

PROGRAMMABLE TOUCH SCREEN CONTROLLER WITH INTEGRATED STEREO AUDIO DAC AND HEADPHONE AMPLIFIER

FEATURES

- 4-Wire Touch Screen Interface
- Integrated Touch Screen Processor With Fully Automated Modes of Operation
- Programmable Converter Resolution, Speed, and Averaging
- Programmable Autonomous Timing Control
- Direct Battery Measurement
- On-Chip Temperature Measurement
- Stereo Audio Playback Up to 48 kbps
- 97-dB Stereo Audio Playback
- Integrated PLL for Audio Clock Generation
- Programmable Digital Audio Effects Processing
- Stereo Headphone Amplifier
- SPI™ Serial Interface
- Glueless Interface With OMAP™ and Xscale™ Processors
- Full Power-Down Control
- Low Power: 11-mW Stereo Audio Playback
- 32-Pin TSSOP Package

APPLICATIONS

- Personal Digital Assistants
- Smart Cellular Phones
- MP3 Players

DESCRIPTION

The TSC2102 is a highly integrated combination resistive touch screen controller with on-chip processor and audio DAC. The touch screen portion of the TSC2102 contains a 12-bit 4-wire resistive touch screen converter complete with drivers, and interfaces to the host controller through a standard SPI™ serial interface. The on-chip processor provides extensive features specifically designed to reduce host processor and bus overhead, with capabilities that include fully automated operating modes, programmable conversion resolution up to 12 bits, programmable sampling rates up to 125 kHz, programmable conversion averaging, and programmable on-chip timing generation.

The TSC2102 also features a high-performance audio DAC with 16, 20, 24, or 32-bit stereo playback functionality at up to 48 kbps. The stereo output drivers on the TSC2102 can be programmed for headphone drive or line-level drive, and support capless as well as ac-coupled output configurations. The digital audio data format is programmable to work with popular audio standard protocols (I2S, DSP, left/right justified) in master or slave mode, and also includes an on-chip PLL for flexible clock generation capability.

The TSC2102 offers two battery measurement inputs capable of reading battery voltages up to 6 V, while operating at only 2.7 V. It also has an on-chip temperature sensor capable of reading 0.3°C resolution. The TSC2102 is available in a 32-lead TSSOP.

US Patent No. 624639



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SPI is a trademark of Motorola.

OMAP is a trademark of Texas Instruments.

Xscale is a trademark of Intel.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

| PRODUCT | PACKAGE | PACKAGE DESIGNATOR | OPERATING TEMPERATURE RANGE | ORDERING NUMBER | TRANSPORT MEDIA |
|------------|----------|--------------------|-----------------------------|-----------------|-----------------|
| TSC2102IDA | TSSOP-32 | 360 | –40°C to +85°C | TSC2102IDA | Rails |
| | | | | TSC2102IDAR | Tape and Reel |

PIN ASSIGNMENTS

(TOP VIEW)

TSSOP

| | | | |
|---------|----|----|-------|
| DIN | 1 | 32 | PWD |
| NC | 2 | 31 | LRCK |
| BCLK | 3 | 30 | RESET |
| DVDD | 4 | 29 | HPR |
| DVSS | 5 | 28 | DRVDD |
| IOVDD | 6 | 27 | VGND |
| MCLK | 7 | 26 | DRVSS |
| SCLK | 8 | 25 | HPL |
| MISO | 9 | 24 | AVDD |
| MOSI | 10 | 23 | X+ |
| SS | 11 | 22 | Y+ |
| PINTDAV | 12 | 21 | X– |
| NC | 13 | 20 | Y– |
| NC | 14 | 19 | AVSS |
| AUX | 15 | 18 | VREF |
| VBAT2 | 16 | 17 | VBAT1 |

Terminal Functions

| PIN | NAME | INPUT/ OUTPUT | DESCRIPTION | PIN | NAME | INPUT/ OUTPUT | DESCRIPTION |
|-----|---------|------------------|---------------------------------------------------------|-----|-------|------------------|---------------------------------|
| 1 | DIN | I | Digital audio data input | 17 | VBAT1 | I | Battery monitor input 1 |
| 2 | NC | | No connection | 18 | VREF | I/O | Reference voltage |
| 3 | BCLK | I/O | Audio bit clock to be consistent with pin 31 word-clock | 19 | AVSS | I | Analog ground |
| 4 | DVDD | I | Digital core supply | 20 | Y– | I/O | Y– position input and driver |
| 5 | DVSS | I | Digital core and IO ground | 21 | X– | I/O | X– position input and driver |
| 6 | IOVDD | I | IO supply | 22 | Y+ | I/O | Y+ position input and driver |
| 7 | MCLK | I | Master clock | 23 | X+ | I/O | X+ position input and driver |
| 8 | SCLK | I | SPI serial clock input | 24 | AVDD | I | Analog power supply |
| 9 | MISO | O | SPI serial data output | 25 | HPL | O | Left channel audio output |
| 10 | MOSI | I | SPI serial data input | 26 | DRVSS | I | Speaker ground |
| 11 | SS | I | SPI slave select input | 27 | VGND | O | Virtual ground for audio output |
| 12 | PINTDAV | O | Pen interrupt/data available output | 28 | DRVDD | I | Speaker and PLL supply |
| 13 | NC | | No connection | 29 | HPR | O | Right channel audio output |
| 14 | NC | | No connection | 30 | RESET | I | Device reset |
| 15 | AUX | I | Auxiliary input | 31 | LRCK | I/O | Audio DAC word-clock |
| 16 | VBAT2 | I | Battery monitor input 2 | 32 | PWD | I | Hardware power down |

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted⁽¹⁾

| | | UNITS |
|-------------------------------------------|-----------------------------------|--------------------------------------------------------|
| AVDD to AVSS | | –0.3 V to 3.9 V |
| DRVDD to DRVSS | | –0.3 V to 3.9 V |
| IOVDD to DVSS | | –0.3 V to 3.9 V |
| DVDD to DVSS | | –0.3 V to 2.5 V |
| Digital input voltage to GND | | –0.3 V to IOVDD + 0.3 V |
| Operating temperature range | | –40°C to 85°C |
| Storage temperature range | | –65°C to 105°C |
| Junction temperature (T _J Max) | | 105°C |
| TSSOP package | Power dissipation | (T _J Max – T _A)/θ _{JA} |
| | θ _{JA} Thermal impedance | 60°C/W |
| Lead temperature | Soldering vapor phase (60 sec) | 215°C |
| | Infrared (15 sec) | 220°C |

(1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

At +25°C, AVDD, DRVDD, IOVDD = 3.3 V, DVDD = 1.8 V, Int. V_{ref} = 2.5 V, Fs (Audio) = 48 kHz, unless otherwise noted

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
|----------------------------|-----------------------------------------------------------------------------------|----------|-------|----------|-------|
| TOUCH SCREEN | | | | | |
| AUXILIARY ANALOG INPUT | | | | | |
| Input voltage range | AUX input selected as input by touch-screen ADC | 0 | | +VREF | V |
| Input capacitance | | | 25 | | pF |
| Input leakage current | | | ±1 | | μA |
| BATTERY MONITOR INPUTS | | | | | |
| Input voltage range | | 0.5 | | 6.0 | V |
| Input leakage current | Battery conversion not selected | | ±1 | | μA |
| TOUCH SCREEN A/D CONVERTER | | | | | |
| Resolution | Programmable: 8-, 10-,12-bits | | | 12 | Bits |
| No missing codes | 12-bit resolution | | 11 | | Bits |
| Integral nonlinearity | | −5 | | 5 | LSB |
| Offset error | | −6 | | 6 | LSB |
| Gain error | Gain error is calculated with the effect of internal reference variation removed. | −6 | | 6 | LSB |
| Noise | | | 50 | | μVrms |
| STEREO AUDIO CODEC | | | | | |
| DAC INTERPOLATION FILTER | | | | | |
| Pass band | | 20 | | 0.45Fs | Hz |
| Pass band ripple | | | ±0.06 | | dB |
| Transition band | | 0.45Fs | | 0.5501Fs | Hz |
| Stop band | | 0.5501Fs | | 7.455Fs | Hz |
| Stop band attenuation | | | 65 | | dB |
| Filter group delay | | | 21/Fs | | Sec |
| De-emphasis error | | | ±0.1 | | dB |

ELECTRICAL CHARACTERISTICS (continued)At +25°C, AVDD, DRVDD, IOVDD = 3.3 V, DVDD = 1.8 V, Int. V_{ref} = 2.5 V, Fs (Audio) = 48 kHz, unless otherwise noted (continued)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
|-----------------------------------------------|---------------------------------------------------------------|-----------|-------|-----------|------------------|
| DAC LINE OUTPUT (16-Ω driver bypassed) | | | | | |
| | 1020-Hz sine wave input, Fs = 48 ksp/s, Load = 10 kΩ, 10 pF | | | | |
| Full scale output voltage (0 dB) | | | 0.707 | | V _{rms} |
| Output common mode | | | 1.35 | | V |
| SNR | Measured as idle channel noise, A-weighted | 85 | 97 | | dBA |
| THD | 0-dB FS input, 0-dB gain | | –97 | | dB |
| PSRR | 1 kHz, 100mV _{pp} on AVDD ⁽¹⁾ | | 55 | | dB |
| DAC HEADPHONE OUTPUT | | | | | |
| | Load = 16 Ω, 10 pF | | | | |
| SNR | Measured as idle channel noise, A-weighted | 85 | 96 | | dBA |
| THD | –1 dBFS input, 0-dB gain | | –65 | –55 | dB |
| PSRR | 1 kHz, 100 mV _{pp} on AVDD ⁽¹⁾ | | 50 | | dB |
| Mute attenuation | | | 90 | | dB |
| Maximum output power | Per channel | | 25 | | mW |
| Digital volume control | | –63.5 | | 0 | dB |
| Digital volume control step size | | | 0.5 | | dB |
| Channel separation | Between HPR and HPL | | 90 | | dB |
| VOLTAGE REFERENCE | | | | | |
| Voltage range | VREF output programmed as 2.5 V | 2.3 | 2.5 | 2.7 | V |
| | VREF output programmed as 1.25 V | 1.15 | 1.25 | 1.35 | |
| Voltage range | External reference | 1.2 | | 2.55 | V |
| Reference drift | Internal VREF = 2.5 V | | 50 | | ppm/°C |
| Current drain | Extra current drawn when the internal reference is turned on. | | 500 | | μA |
| DIGITAL INPUT / OUTPUT | | | | | |
| Internal clock frequency | | | 8 | | MHz |
| Logic family | | | CMOS | | |
| Logic level: V _{IH} | I _{IH} = +5 μA | 0.7xIOVDD | | | V |
| V _{IL} | I _{IL} = +5 μA | –0.3 | | 0.3xIOVDD | V |
| V _{OH} | I _{OH} = 2 TTL loads | 0.8xIOVDD | | | V |
| V _{OL} | I _{OL} = 2 TTL loads | | | 0.1xIOVDD | V |
| Capacitive load | | | 10 | | pF |

ELECTRICAL CHARACTERISTICS (continued)

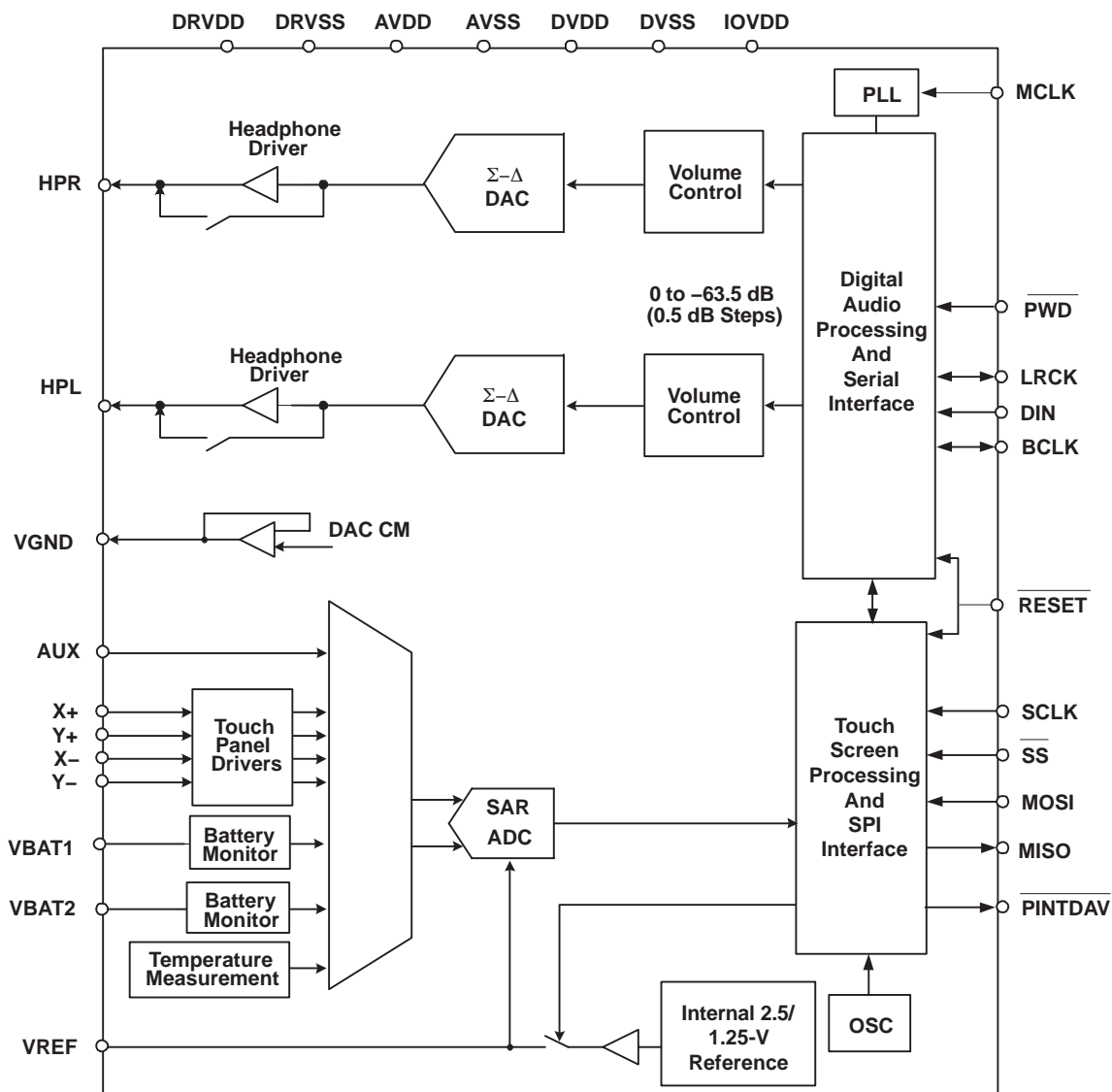
At +25°C, AVDD, DRVDD, IOVDD = 3.3 V, DVDD = 1.8 V, Int. V_{ref} = 2.5 V, Fs (Audio) = 48 kHz, unless otherwise noted (continued)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
|-----------------------------------------------|--------------------------------------------------------------------------|-------|-----|------|-------|
| POWER SUPPLY REQUIREMENTS | | | | | |
| Power supply voltage | | | | | |
| AVDD | | 2.7 | | 3.6 | V |
| DRVDD | | 2.7 | | 3.6 | V |
| IOVDD | | 2.7 | | 3.6 | V |
| DVDD | | 1.525 | | 1.95 | V |
| Touch-screen ADC quiescent current | IAVDD, host controlled AUX conversion at 10 ksps with external reference | | 45 | | μA |
| | IDVDD, host controlled AUX conversion at 10 ksps | | 65 | | |
| Analog supply current – Audio play back only | IAVDD + IDRVDD, headphone driver bypassed, VGND off, PLL off, no signal | | 2.1 | | mA |
| | IAVDD + IDRVDD, headphone driver and VGND on, PLL off, no signal | | 7.1 | | |
| Digital supply current – Audio play back only | 48 ksps, PLL off, no signal | | 2.2 | | mA |
| PLL current | IDRVDD | | 1 | | mA |
| | IDVDD | | 0.8 | | |
| Total current | Hardware power down. All digital inputs at 0 V or IOVDD. | | 5 | | μA |

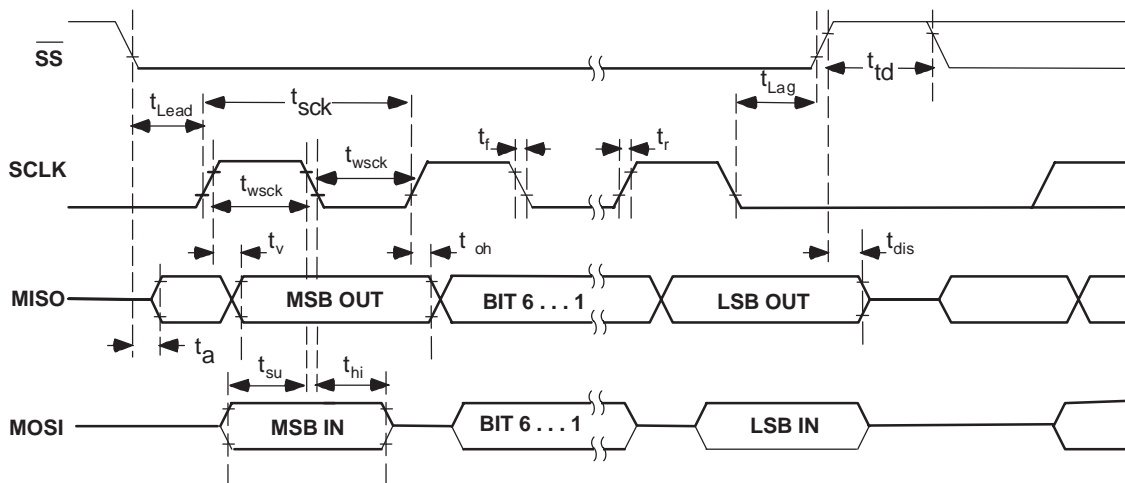
(1) DAC PSRR measurement is calculated as:

$$PSRR = 20 \log_{10} \left(\frac{VSIG_{sup}}{V_{HPR/L}} \right)$$

where VSIG_{sup} is the ac signal applied on AVDD, which is 100 mV_{pp} at 1 kHz, and V_{HPR/L} is the peak-to-peak ac signal seen on HPR and HPL outputs.

FUNCTIONAL BLOCK DIAGRAM

SPI TIMING DIAGRAM

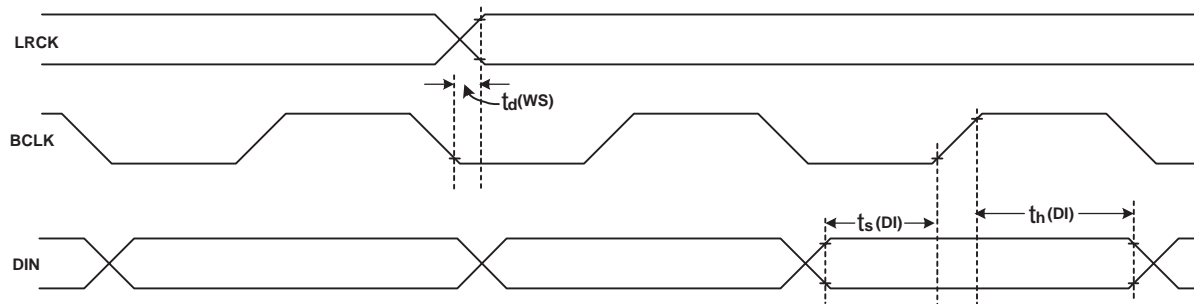


TYPICAL TIMING REQUIREMENTS

All specifications at 25°C, IOVDD = 3.3 V, DVDD = 1.8 V⁽¹⁾

| PARAMETER | MIN | MAX | UNITS |
|------------------------------------|-----|-----|-------|
| t_{wsck} SCLK pulse width | 18 | | ns |
| t_{Lead} Enable lead time | 15 | | ns |
| t_{Lag} Enable lag time | 15 | | ns |
| t_{td} Sequential transfer delay | 15 | | ns |
| t_a Slave MISO access time | | 15 | ns |
| t_{dis} Slave MISO disable time | | 15 | ns |
| t_{su} MOSI data setup time | 6 | | ns |
| t_{hi} MOSI data hold time | 6 | | ns |
| t_{ho} MISO data hold time | 4 | | ns |
| t_v MISO data valid time | | 13 | ns |
| t_r Rise time | | 4 | ns |
| t_f Fall time | | 4 | ns |

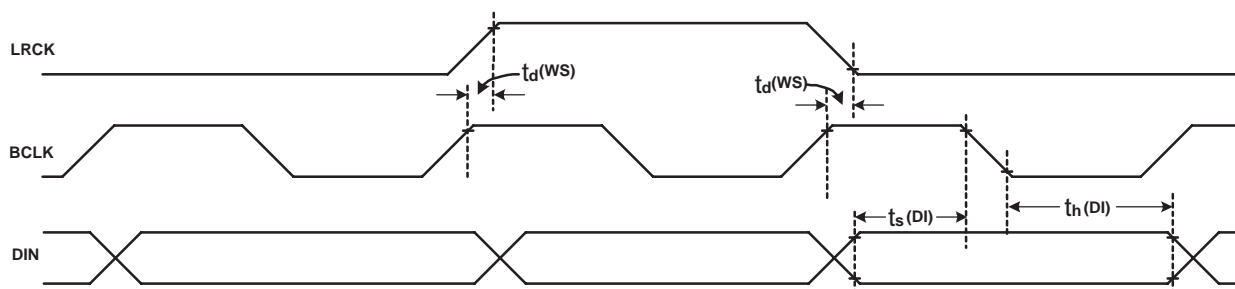
⁽¹⁾ These parameters are based on characterization and are not tested in production.

AUDIO INTERFACE TIMING DIAGRAMS**Figure 1. I2S/LJF/RJF Timing in Master Mode****TYPICAL TIMING REQUIREMENTS**

All specifications at 25°C, IOVDD = 3.3 V, DVDD = 1.8 V(1)

| PARAMETER | | MIN | MAX | UNITS |
|------------|------------|-----|-----|-------|
| t_d (WS) | LRCK delay | | 15 | ns |
| t_s (DI) | DIN setup | 6 | | ns |
| t_h (DI) | DIN hold | 6 | | ns |
| t_r | Rise time | | 6 | ns |
| t_f | Fall time | | 6 | ns |

(1) These parameters are based on characterization and are not tested in production.

**Figure 2. DSP Timing in Master Mode****TYPICAL TIMING REQUIREMENTS**

All specifications at 25°C, IOVDD = 3.3 V, DVDD = 1.8 V(1)

| PARAMETER | | MIN | MAX | UNITS |
|------------|------------|-----|-----|-------|
| t_d (WS) | LRCK delay | | 15 | ns |
| t_s (DI) | DIN setup | 6 | | ns |
| t_h (DI) | DIN hold | 6 | | ns |
| t_r | Rise time | | 6 | ns |
| t_f | Fall time | | 6 | ns |

(1) These parameters are based on characterization and are not tested in production.

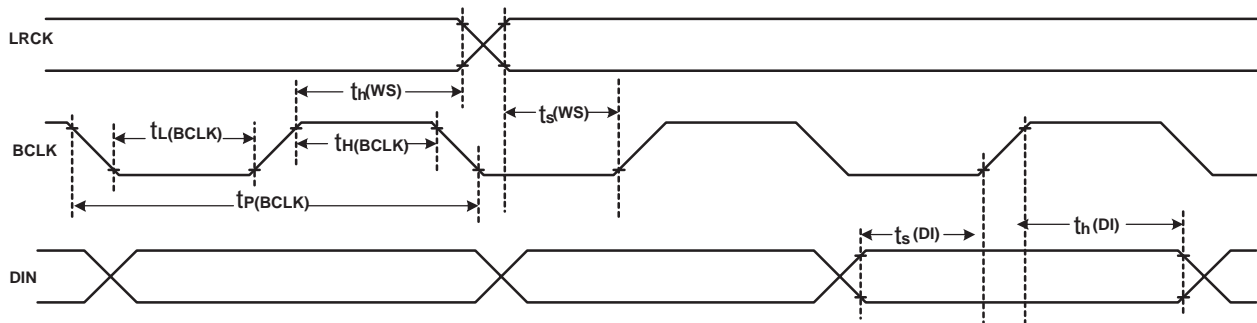


Figure 3. I2S/LJF/RJF Timing in Slave Mode

TYPICAL TIMING REQUIREMENTS

All specifications at 25°C, IOVDD = 3.3 V, DVDD = 1.8 V⁽¹⁾

| PARAMETER | | MIN | MAX | UNITS |
|--------------|------------------|-----|-----|-------|
| t_H (BCLK) | BCLK high period | 35 | | ns |
| t_L (BCLK) | BCLK low period | 35 | | ns |
| t_P (BCLK) | BCLK period | 85 | | ns |
| t_S (WS) | LRCK setup | 6 | | ns |
| t_H (WS) | LRCK hold | 6 | | ns |
| t_S (DI) | DIN setup | 6 | | ns |
| t_H (DI) | DIN hold | 6 | | ns |
| t_r | Rise time | | 4 | ns |
| t_f | Fall time | | 4 | ns |

⁽¹⁾ These parameters are based on characterization and are not tested in production.

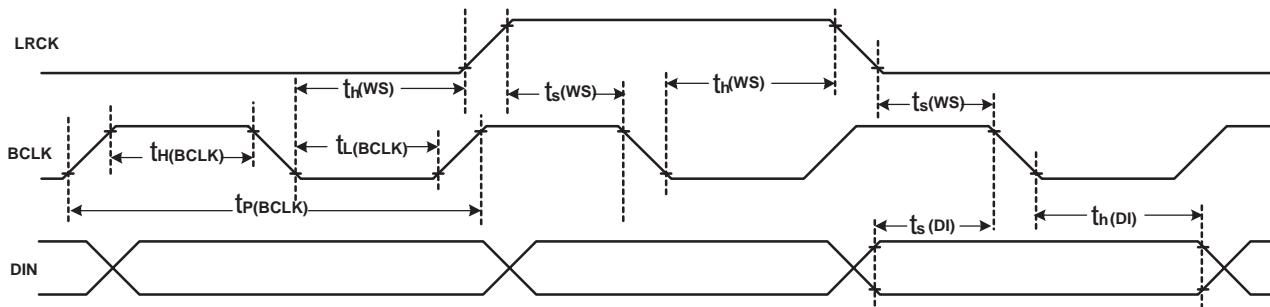


Figure 4. DSP Timing in Slave Mode

TYPICAL TIMING REQUIREMENTS

All specifications at 25°C, IOVDD = 3.3 V, DVDD = 1.8 V⁽¹⁾

| PARAMETER | | MIN | MAX | UNITS |
|--------------|------------------|-----|-----|-------|
| t_H (BCLK) | BCLK high period | 35 | | ns |
| t_L (BCLK) | BCLK low period | 35 | | ns |
| t_P (BCLK) | BCLK period | 85 | | ns |
| t_S (WS) | LRCK setup | 6 | | ns |
| t_H (WS) | LRCK hold | 6 | | ns |
| t_S (DI) | DIN setup | 6 | | ns |
| t_H (DI) | DIN hold | 6 | | ns |
| t_r | Rise time | | 4 | ns |
| t_f | Fall time | | 4 | ns |

⁽¹⁾ These parameters are based on characterization and are not tested in production.

TYPICAL CHARACTERISTICS

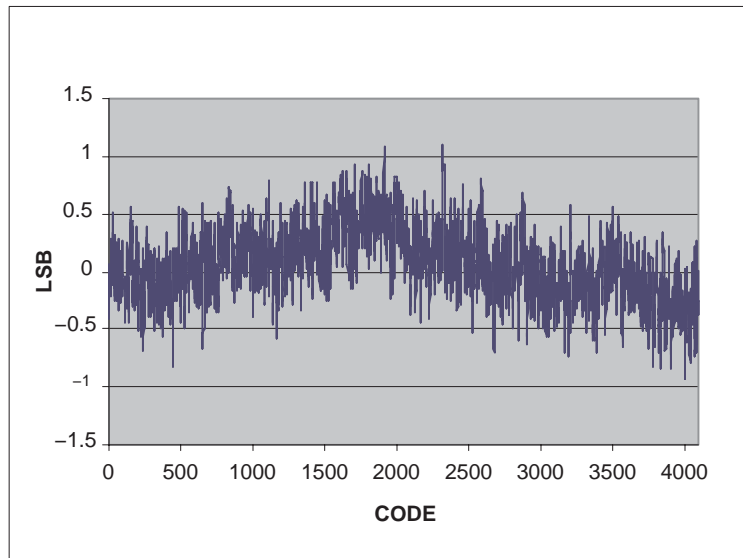


Figure 5. SAR INL ($T_A = 25^\circ\text{C}$, Internal Ref = 2.5 V, 12 bit, AVDD = 3.3 V)

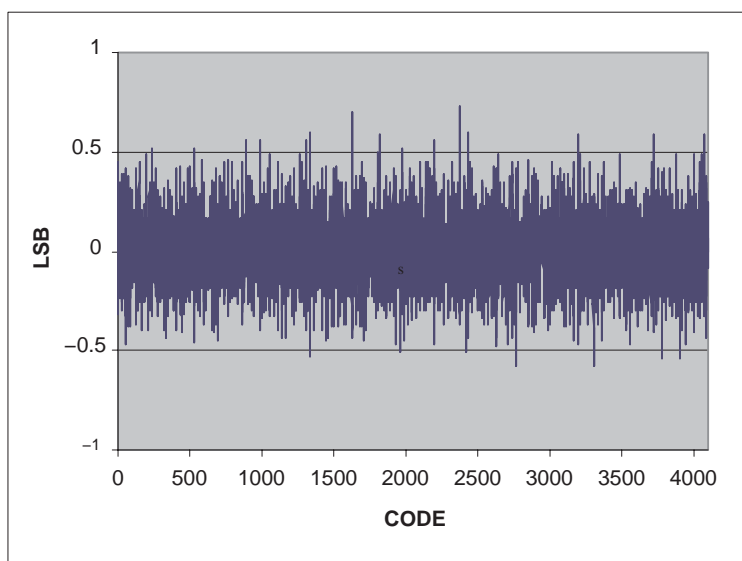


Figure 6. SAR DNL ($T_A = 25^\circ\text{C}$, Internal Ref = 2.5 V, AVDD = 3.3 V)

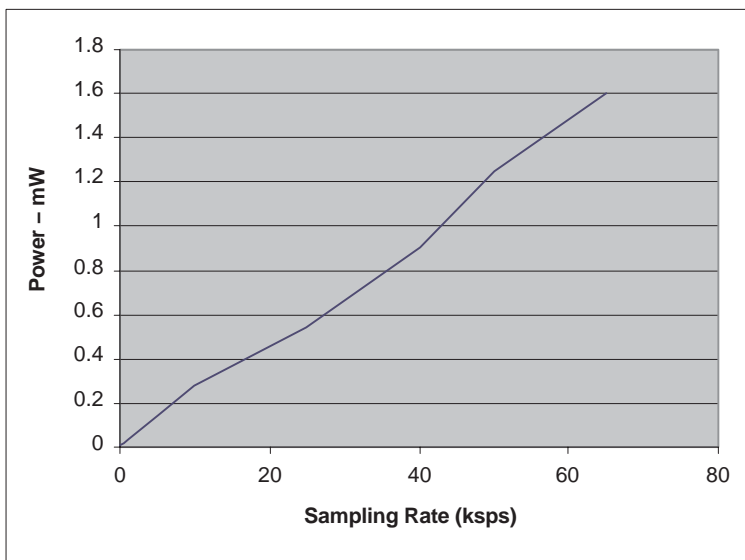


Figure 7. Touch Screen Power Consumption With Speed ($T_A = 25^\circ\text{C}$, External Ref, Host Controlled AUX Conversion, AVDD = 3.3 V)

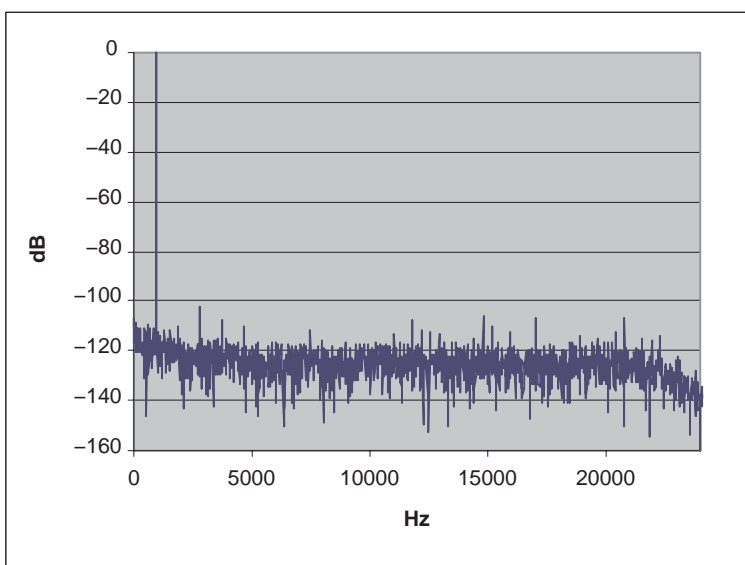


Figure 8. DAC FFT Plot ($T_A = 25^\circ\text{C}$, 48 ksps, 0 dB, 1 kHz Input, AVDD = 3.3 V, $R_L = 10\text{ k}\Omega$)

OVERVIEW

The TSC2102 is a highly integrated touch screen controller with stereo audio DAC for portable computing, communication, and entertainment applications. A register-based architecture eases integration with microprocessor-based systems through a standard SPI bus. All peripheral functions are controlled through the registers and onboard state machines.

The TSC2102 consists of the following blocks (refer to the block diagram):

- Touch Screen Interface
- Battery Monitors
- Auxiliary Input
- Temperature Monitor
- Audio DAC

Communication with the TSC2102 is via standard SPI serial interface. This interface requires that the slave select signal be driven low to communicate with the TSC2102. Data is then shifted into or out of the TSC2102 under control of the host microprocessor, which also provides the serial data clock. Control of the TSC2102 and its functions is accomplished by writing to different registers in the TSC2102. A simple command protocol is used to address the 16-bit registers. Registers control the operation of the A/D converter and audio DAC.

Control of the TSC2102 and its functions is accomplished by writing to different registers in the TSC2102. A simple command protocol is used to address the 16-bit registers. Registers control the operation of the A/D converter and audio DAC.

The TSC2102 audio serial interface is exclusively used by the stereo DAC and supports four audio interface modes (I2S, DSP, right justified, and left justified) to receive digital audio data from the host processor.

A typical application of the TSC2102 is shown in Figure 9.

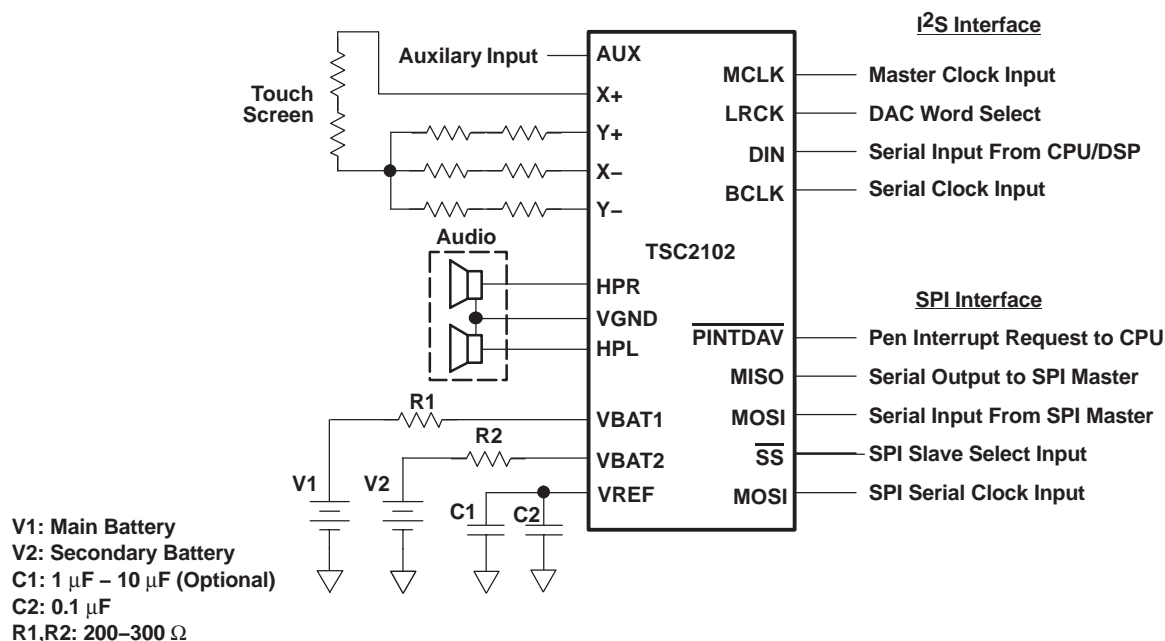


Figure 9. Typical Circuit Configuration

OPERATION—TOUCH SCREEN

A resistive touch screen works by applying a voltage across a resistor network and measuring the change in resistance at a given point on the matrix where a screen is touched by an input stylus, pen, or finger. The change in the resistance ratio marks the location on the touch screen.

The TSC2102 supports the resistive 4-wire configurations (see Figure 9). The circuit determines location in two coordinate pair dimensions, although a third dimension can be added for measuring pressure.

The 4-Wire Touch Screen Coordinate Pair Measurement

A 4-wire touch screen is constructed as shown in Figure 10. It consists of two transparent resistive layers separated by insulating spacers.

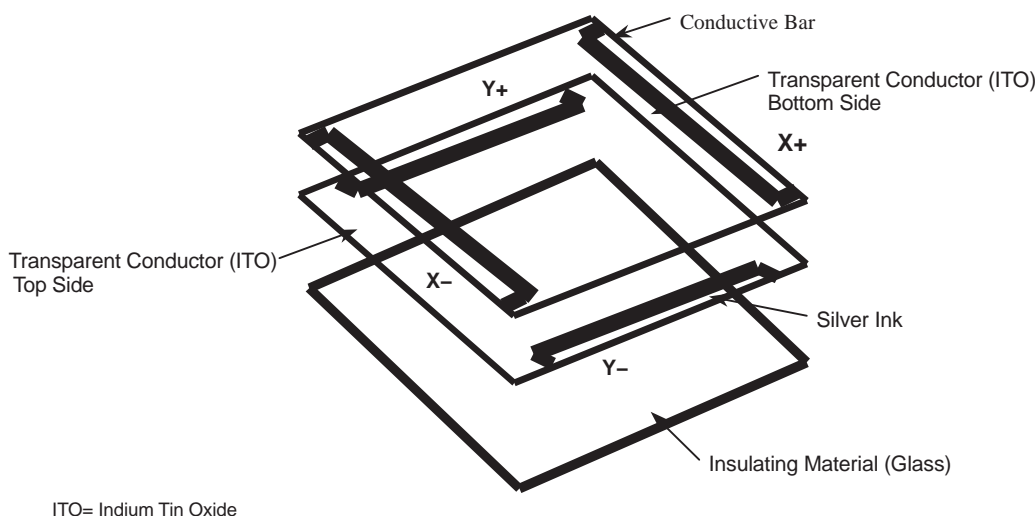


Figure 10. 4-Wire Touch Screen Construction

The 4-wire touch screen panel works by applying a voltage across the vertical or horizontal resistive network. The ADC converts the voltage measured at the point the panel is touched. A measurement of the Y position of the pointing device is made by connecting the X+ input to an ADC, turning on the Y drivers, and digitizing the voltage seen at the X+ input. The voltage measured is determined by the voltage divider developed at the point of touch. For this measurement, the horizontal panel resistance in the X+ lead does not affect the conversion due to the high input impedance of the A/D converter.

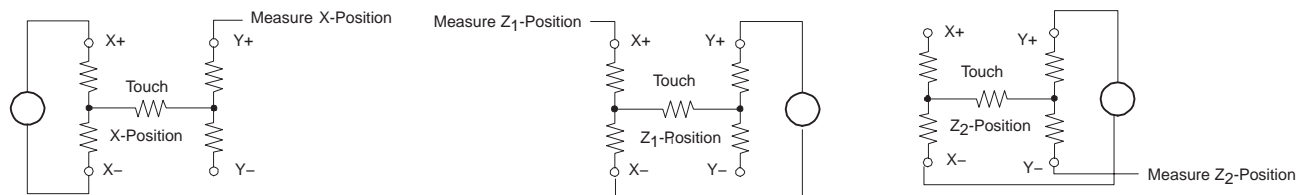
Voltage is then applied to the other axis, and the A/D converts the voltage representing the X position on the screen. This provides the X and Y coordinates to the associated processor.

Measuring touch pressure (Z) can also be done with the TSC2102. To determine pen or finger touch, the pressure of the *touch* needs to be determined. Generally, it is not necessary to have very high performance for this test; therefore, the 8-bit resolution mode is recommended (however, calculations are shown with the 12-bit resolution mode). There are several different ways of performing this measurement. The TSC2102 supports two methods. The first method requires knowing the X-plate resistance, measurement of the X-Position, and two additional cross panel measurements (Z₂ and Z₁) of the touch screen (see Figure 11). Using equation 1 calculates the touch resistance:

$$R_{\text{TOUCH}} = R_{\text{X-plate}} \times \frac{\text{X-position}}{4096} \left(\frac{Z_2 - 1}{Z_1} \right) \quad (1)$$

The second method requires knowing both the X-plate and Y-plate resistance, measurement of X-Position and Y-Position, and Z₁. Using equation 2 also calculates the touch resistance:

$$R_{\text{TOUCH}} = \frac{R_{\text{X-plate}} \times \text{X-position}}{4096} \left(\frac{4096}{Z_1} - 1 \right) - R_{\text{Y-plate}} \times \left(1 - \frac{\text{Y-position}}{4096} \right) \quad (2)$$

**Figure 11. Pressure Measurement**

When the touch panel is pressed or touched, and the drivers to the panel are turned on, the voltage across the touch panel often overshoots and then slowly settles (decays) to a stable dc value. This is due to mechanical bouncing which is caused by vibration of the top layer sheet of the touch panel when the panel is pressed. This settling time must be accounted for, or else the converted value will be in error. Therefore, a delay must be introduced between the time the driver for a particular measurement is turned on, and the time measurement is made.

In some applications, external capacitors may be required across the touch screen for filtering noise picked up by the touch screen, i.e. noise generated by the LCD panel or back-light circuitry. The value of these capacitors provides a low-pass filter to reduce the noise, but causes an additional settling time requirement when the panel is touched.

Several solutions to this problem are available in the TSC2102. A programmable delay time is available which sets the delay between turning the drivers on and making a conversion. This is referred to as the panel voltage stabilization time, and is used in some of the modes available in the TSC2102. In other modes, the TSC2102 can be commanded to turn on the drivers only without performing a conversion. Time can then be allowed before the command is issued to perform a conversion.

The TSC2102 touch screen interface can measure position (X, Y) and pressure (Z). Determination of these coordinates is possible under three different modes of the A/D converter: (1) conversion controlled by the TSC2102, initiated by detection of a touch; (2) conversion controlled by the TSC2102, initiated by the host responding to the $\overline{\text{PINTDAV}}$ signal; or (3) conversion completely controlled by the host processor.

Touch-Screen A/D Converter

The analog inputs of the TSC2102 are shown in Figure 12. The analog inputs (X, Y, and Z touch panel coordinates, battery voltage monitors, chip temperature and auxiliary input) are provided via a multiplexer to the successive approximation register (SAR) analog-to-digital (A/D) converter. The A/D architecture is based on a capacitive redistribution architecture, which inherently includes a sample/hold function.

A unique configuration of low on-resistance switches allows an unselected A/D input channel to provide power and an accompanying pin to provide ground for driving the touch panel. By maintaining a differential input to the converter and a differential reference input architecture, it is possible to negate errors caused by the driver switch on-resistances.

The A/D is controlled by an A/D converter control register. Several modes of operation are possible, depending upon the bits set in the control register. Channel selection, scan operation, averaging, resolution, and conversion rate may all be programmed through this register. These modes are outlined in the sections below for each type of analog input. The results of conversions made are stored in the appropriate result register.

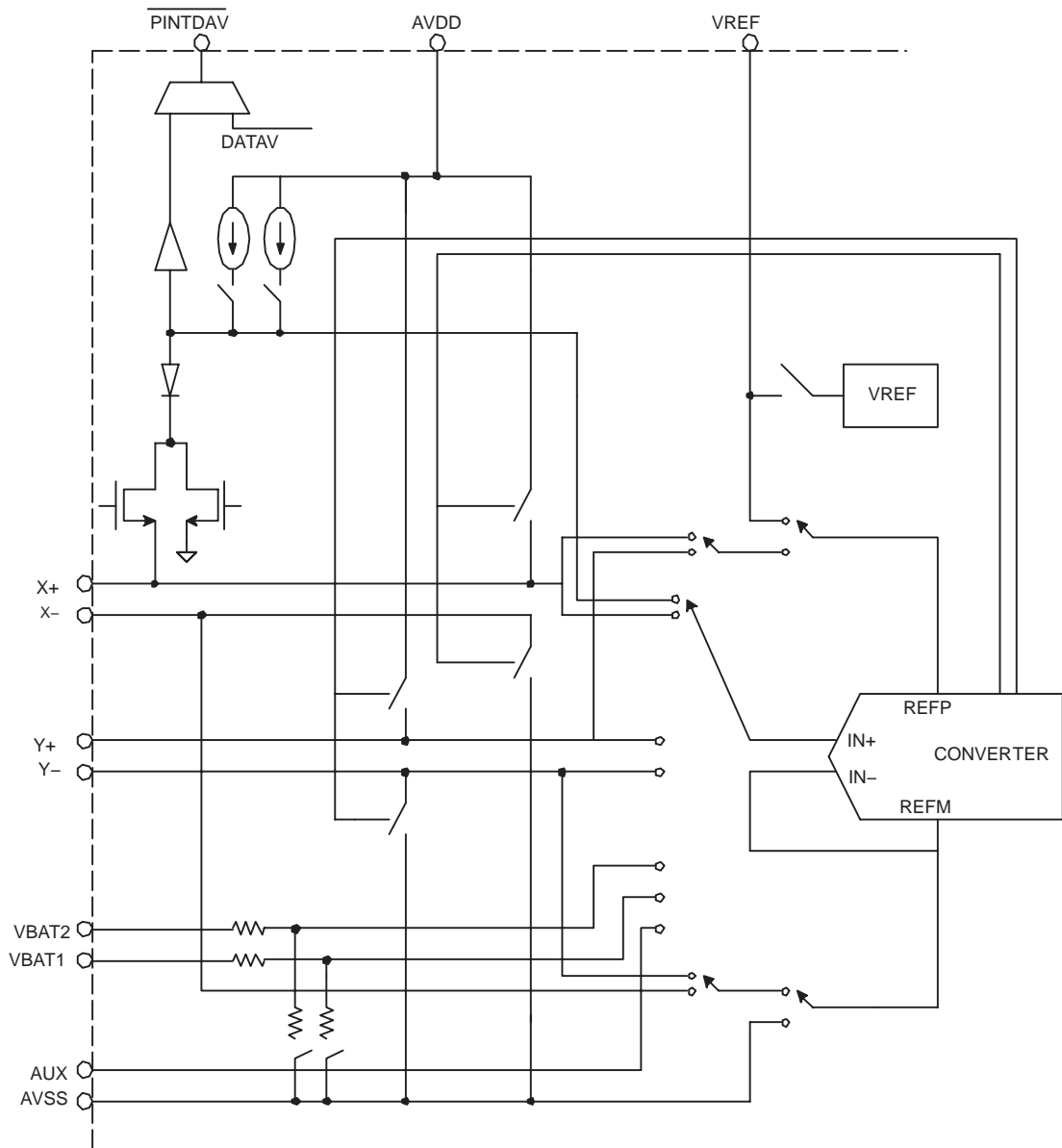


Figure 12. Simplified Diagram of the Analog Input Section

Data Format

The TSC2102 output data is in unsigned binary format and can be read from the registers over the SPI interface.

Reference

The TSC2102 has an internal voltage reference that can be set to 1.25 V or 2.5 V through the reference control register.

The internal reference voltage must only be used in the single-ended mode for battery monitoring, temperature measurement, and for utilizing the auxiliary inputs. Optimal touch screen performance is achieved when using a ratiometric conversion, thus all touch screen measurements are done automatically in the ratiometric mode.

An external reference can also be applied to the VREF pin, and the internal reference can be turned off.

Variable Resolution

The TSC2102 provides three different resolutions for the ADC: 8-, 10- or 12-bits. Lower resolutions are often practical for measurements such as touch pressure. Performing the conversions at lower resolution reduces the amount of time it takes for the ADC to complete its conversion process, which lowers power consumption.

Conversion Clock and Conversion Time

The TSC2102 contains an internal 8-MHz clock, which is used to drive the state machines inside the device that perform the many functions of the part. This clock is divided down to provide a clock to run the ADC. The division ratio for this clock is set in the ADC control register. The ability to change the conversion clock rate allows the user to choose the optimal value for resolution, speed, and power. If the 8-MHz clock is used directly, the ADC is limited to 8-bit resolution; using higher resolutions at this speed does not result in accurate conversions. Using a 4-MHz conversion clock is suitable for 10-bit resolution; 12-bit resolution requires that the conversion clock run at 1 or 2 MHz.

Regardless of the conversion clock speed, the internal clock runs nominally at 8 MHz. The conversion time of the TSC2102 is dependent upon several functions (see the section *Touch Screen Conversion Initiated at Touch Detect* in this data sheet). While the conversion clock speed plays an important role in the time it takes for a conversion to complete, a certain number of internal clock cycles is needed for proper sampling of the signal. Moreover, additional times, such as the panel voltage stabilization time, can add significantly to the time it takes to perform a conversion. Conversion time can vary depending upon the mode in which the TSC2102 is used. Throughout this data sheet, internal and conversion clock cycles are used to describe the times that many functions take to execute. Considering the total system design, these times must be taken into account by the user.

When the audio DAC is powered down, the touch screen A/D uses an internal oscillator for conversions. However, to save power whenever the audio DAC is powered up, the internal oscillator is powered down and MCLK and BCLK are used to clock the touch screen A/D.

Touch Detect/Data Available

The pen interrupt/data available ($\overline{\text{PINTDAV}}$) output function is detailed in Figure 13. While in the power-down mode, the Y– driver is ON and connected to AVSS and the X+ pin is connected through an on-chip pullup resistor to AVDD. In this mode, the X+ pin is also connected to a digital buffer and mux to drive the $\overline{\text{PINTDAV}}$ output. When the panel is touched, the X+ input is pulled to ground through the touch screen, and the pen-interrupt signal goes LOW due to the current path through the panel to AVSS, initiating an interrupt to the processor. During the measurement cycles for X– and Y– position, the X+ input is disconnected from the pen-interrupt circuit to prevent any leakage current from the pullup resistor flowing through the touch screen, and thus causing conversion errors.

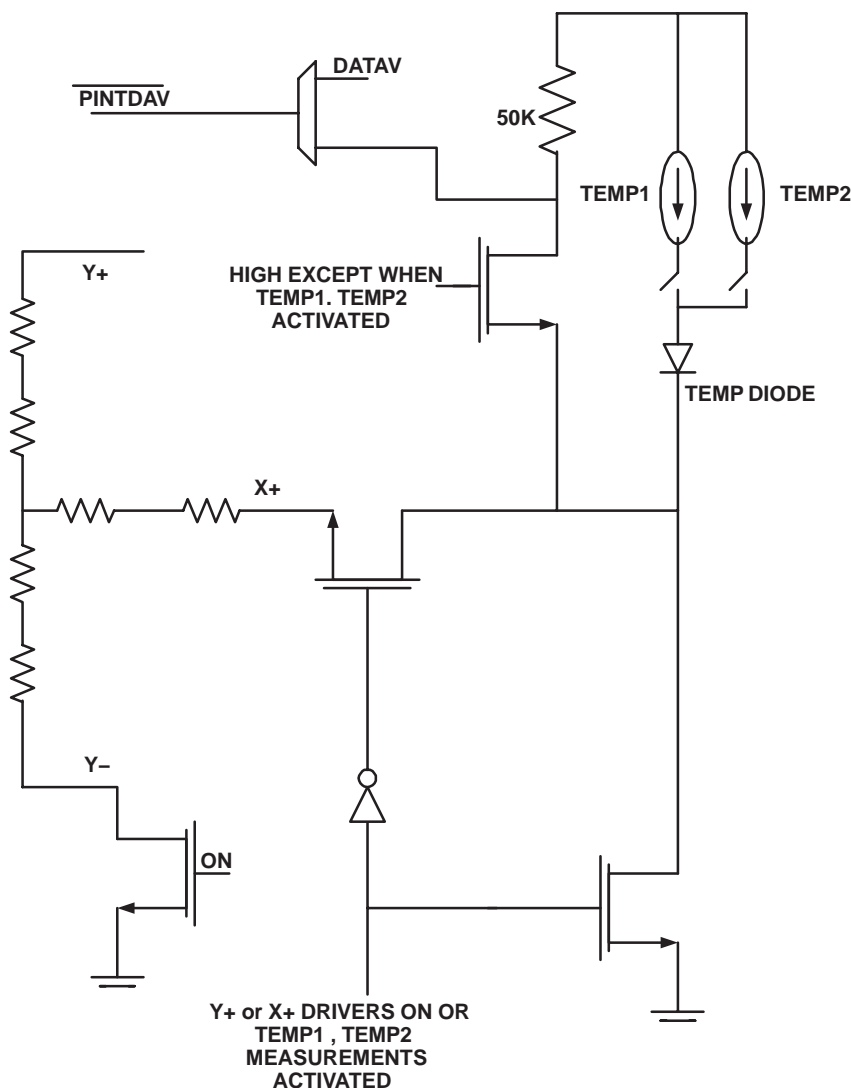


Figure 13. PINTDAV Functional Block Diagram

In modes where the TSC2102 needs to detect if the screen is still touched (for example, when doing a PINTDAV initiated X, Y, and Z conversion), the TSC2102 must reset the drivers so that the 50-k resistor is connected. Because of the high value of this pullup resistor, any capacitance on the touch screen inputs causes a long delay time, and may prevent the detection from occurring correctly. To prevent this, the TSC2102 has a circuit that allows any screen capacitance to be *precharged*, so that the pullup resistor does not have to be the only source for the charging current. The time allowed for this precharge, as well as the time needed to sense if the screen is still touched, can be set in the configuration control register D5–D0 of REG05H/Page1.

This does point out, however, the need to use the minimum capacitor values possible on the touch screen inputs. These capacitors may be needed to reduce noise, but too large a value increases the needed precharge and sense times, as well as panel voltage stabilization time.

The function of PINTDAV output is programmable and controlled by writing to the bits D15–D14 of REG 01H/Page1 as described in the Table 1.

Table 1. Programmable $\overline{\text{PINTDAV}}$ Functionality

| D15–D14 | $\overline{\text{PINTDAV}}$ FUNCTION |
|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 00 | Acts as PEN interrupt (active low) only. When PEN touch is detected, $\overline{\text{PINTDAV}}$ goes low. ⁽¹⁾ |
| 01 | Acts as data available (active low) only. The $\overline{\text{PINTDAV}}$ goes low as soon as one set of ADC conversions are completed for data of X,Y, XYZ, battery input, or auxiliary input selected by D13–D10 in REG00H/Page1. The resulting ADC output is stored in the appropriate registers. The $\overline{\text{PINTDAV}}$ remains low and goes high only after this complete set of registers selected by D13–D10 REG00H/Page1 is read out. |
| 10 11 | Acts as both PEN interrupt and data available. When PEN touch is detected, $\overline{\text{PINTDAV}}$ goes low and remains low. The $\overline{\text{PINTDAV}}$ goes high only after one set of A/D conversions is completed for data of X,Y, XYZ, battery input, or auxiliary input selected by D13–D10 in REG00H/Page1. |

⁽¹⁾ See the section *Conversion Time Calculation for the TSC2102* in this data sheet for timing diagrams and conversion time calculations.

Pen-touch detect circuit is disabled during hardware power down.

Touch Screen Measurements

The touch screen ADC can be controlled by the host processor or can be self-controlled to offload processing from the host processor. Bit D15 of REG00H/Page1 sets the control mode of the TSC2102 touch screen ADC; and bit D12 of REG01H/Page 1 can be read to check the control mode status.

Conversion Controlled by TSC2102 Initiated at Touch Detect

In this mode, the TSC2102 detects when the touch panel is touched and causes the $\overline{\text{PINTDAV}}$ line to go low. At the same time, the TSC2102 starts up its internal clock. Assuming the part was configured to convert XY coordinates, it then turns on the Y drivers, and after a programmed panel voltage stabilization time, powers up the ADC and converts the Y coordinate. If averaging is selected, several conversions may take place; when data averaging is complete, the Y coordinate result is stored in the Y register.

If the screen is still touched at this time, the X drivers are enabled, and the process repeats, but measuring instead the X coordinate, storing the result in the X register.

If only X and Y coordinates are to be measured, then the conversion process is complete. The time it takes to complete this process depends upon the selected resolution, internal conversion clock rate, averaging selected, panel voltage stabilization time, and precharge and sense times.

If the pressure of the touch is also to be measured, the process continues in the same way, measuring the Z1 and Z2 values, and placing them in the Z1 and Z2 registers. As before, this process time depends upon the settings described above.

See the section *Conversion Time Calculation for the TSC2102* in this data sheet for timing diagrams and conversion time calculations.

Conversion Controlled by TSC2102 Initiated by the Host

In this mode, the TSC2102 detects when the touch panel is touched and causes the pen-interrupt signal line to go low. The host recognizes the interrupt request, and then writes to the ADC control register (D13–D10 REG00H/Page1) to select one of the touch screen scan functions. The host can either choose to initiate one of the scan functions, in which case the TSC2102 controls the driver turnons, and wait times (e.g. upon receiving the interrupt the host can initiate the continuous scan function X–Y–Z1–Z2 after which the TSC2102 controls the rest of conversion). The host can also choose to control each aspect of conversion by controlling the driver turnons and start of conversions. For example, upon receiving the interrupt request, the host turns on the X drivers. After waiting for the settling time, the host then addresses the TSC2102 again, this time requesting an X coordinate conversion, and so on.

The main difference between this mode and the previous mode is that the host, not the TSC2102, controls the touch screen scan functions.

See the section *Conversion Time Calculation for the TSC2102* in this data sheet for timing diagrams and conversion time calculations.

Temperature Measurement

In some applications, such as battery recharging, a measurement of ambient temperature is required. The temperature measurement technique used in the TSC2102 relies on the characteristics of a semiconductor junction operating at a fixed current level. The forward diode voltage (V_{BE}) has a well-defined characteristic versus temperature. The ambient temperature can be predicted in applications by knowing the 25°C value of the V_{BE} voltage and then monitoring the delta of that voltage as the temperature changes.

The TSC2102 offers two modes of temperature measurement. The first mode requires a single reading to predict the ambient temperature. A diode, as shown in Figure 14, is used during this measurement cycle. This voltage is typically 600 mV at 25°C with a 20-μA current through it. The absolute value of this diode voltage can vary a few millivolts. During the final test of the end product, the diode voltage must be stored at a known temperature. Further calibration can be done to calculate the precise temperature coefficient of the particular device. This method has a temperature resolution of approximately 0.3 °C/LSB and accuracy of approximately 1°C.

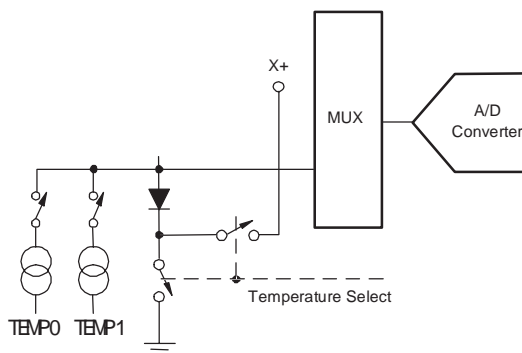


Figure 14. Functional Block Diagram of Temperature Measurement Mode

The second mode uses a two-measurement (differential) method. This mode requires a second conversion with a current 82 times larger. The voltage difference between the first (TEMP1) and second (TEMP2) conversion, using 82 times the bias current, is represented by:

$$\frac{kT}{q} \times \ln(N)$$

where:

N is the current ratio = 82

k = Boltzmann's constant ($1.38054 \cdot 10^{-23}$ electrons volts/degrees Kelvin)

q = the electron charge ($1.602189 \cdot 10^{-19}$ °C)

T = the temperature in degrees Kelvin

This method provides resolution of approximately 1.5°C/LSB and accuracy of approximately 1°C. The equation for the relation between differential code and temperature may vary slightly from device to device and can be calibrated at final system test by the user.

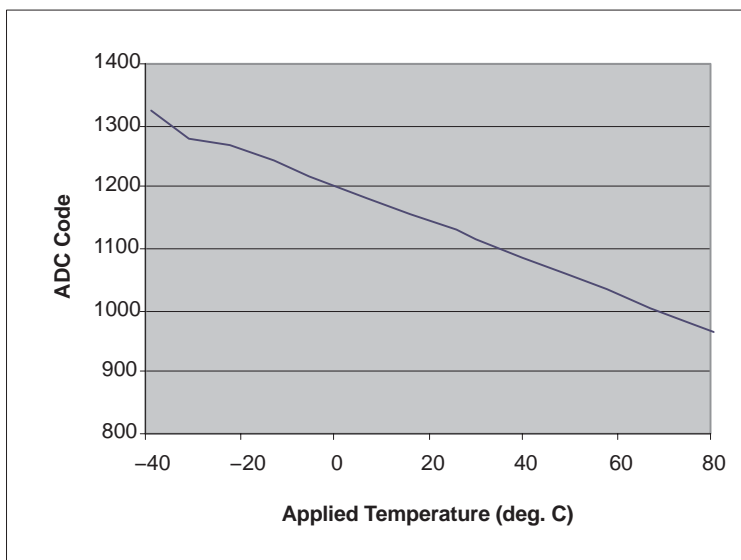


Figure 15. Typical Plot for Single Measurement Method

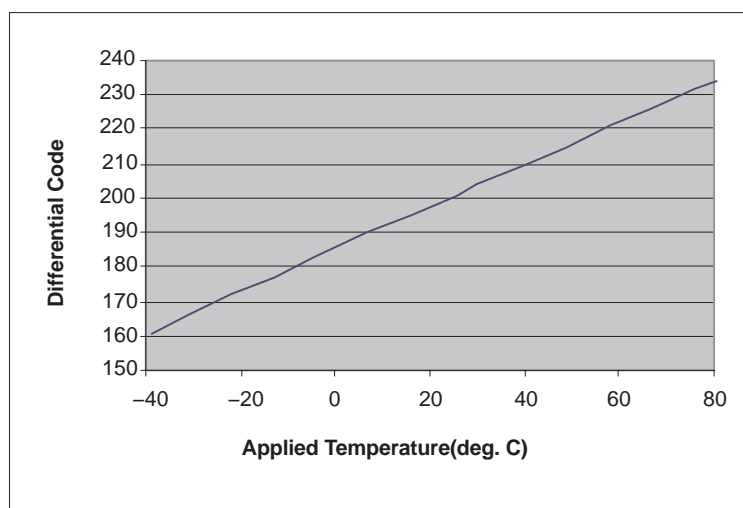


Figure 16. Typical Plot for Differential Measurement Method

Temperature measurement can only be done in host controlled mode.

Battery Measurement

An added feature of the TSC2102 is the ability to monitor the battery voltage at the input side of a voltage regulator (LDO or dc/dc converter), as shown in Figure 17. The battery voltage can vary from 0.5 V to 6 V while maintaining the analog supply voltage to the TSC2102 in the range of 2.7 V to 3.6 V. The input voltage (VBAT1 or VBAT2) is divided down by a factor of 6 so that a 6.0-V battery voltage is represented as 1.0 V to the ADC. It is advisable to add a series resistor of 200 to 300 Ω while connecting the battery terminal to the input pin (VBAT1 or VBAT2) as shown in Figure 17. Thus, the resultant voltage converted by the ADC is given by:

$$V_{\text{conv}} = \frac{2.0K}{12.0K + R} \times V_{\text{battery}}$$

The internal resistors, which make up the resistor divider, are subject to $\pm 20\%$ device-to-device variation. In order to minimize power consumption, the divider is only on during the sampling of the battery input.

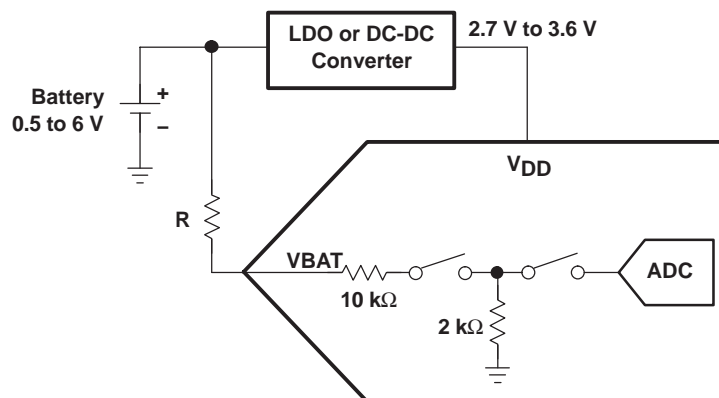


Figure 17. Battery Measurement Functional Block Diagram

Battery measurement can only be done in host controlled mode.

See the section *Conversion Time Calculation for the TSC2102* and subsection *Non Touch Measurement Operation* in this data sheet for timing diagrams and conversion time calculations.

Auxiliary Measurement

The auxiliary voltage input (AUX) can be measured in much the same way as the battery inputs. Applications might include external temperature sensing, ambient light monitoring for controlling the back-light, or sensing the current drawn from the battery. The auxiliary input can also be monitored continuously in scan mode.

Auxiliary measurement can only be done in host controlled mode.

See the section *Conversion Time Calculation for the TSC2102* and subsection *Non Touch Measurement Operation* in this data sheet for timing diagrams and conversion time calculations.

Port Scan

If making measurements of BAT1, BAT2, and AUX is desired on a periodic basis, the port scan mode can be used. This mode causes the TSC2102 to sample and convert both battery inputs and the auxiliary input. At the end of this cycle, the battery and auxiliary result registers contain the updated values. Thus, with one write to the TSC2102, the host can cause three different measurements to be made.

Port scan can only be done in host-controlled mode.

See the section *Conversion Time Calculation for the TSC2102* and subsection *Port Scan Operation* in this data sheet for timing diagrams and conversion time calculations.

Hardware Reset

The device requires hardware reset (active low) after power up. A hardware reset pulse initializes all the internal registers and counters.

Hardware Power Down

The device powers down all the internal circuitry to save power. All the register contents are maintained. Some counters maintain their value. The hardware power-down circuit also disables the pen-touch detect circuit.

OPERATION– STEREO AUDIO DAC

Audio Analog I/O

The TSC2102 has one stereo headphone output capable of driving a 16-Ω load at over 25 mW (with 3.3-V supply) (HPR, HPL). The headphone driver can be bypassed by setting D12 in the control register 05H/Page2 to 0. The TSC2102 also has a virtual ground (VGND) output, which can be optionally used to connect to the ground terminal of headphones to eliminate the ac-coupling capacitor at the headphone output terminal. Bit D8 of control register 05H/Page2 controls the VGND amplifier. A special circuit has been included in the TSC2102 to insert a short keyclick sound into the stereo audio output, even when the audio DAC is powered down. The keyclick sound is used to provide feedback to the user when a particular button is pressed or item is selected. The specific sound of the keyclick can be adjusted by varying several register bits that control its frequency, duration, and amplitude.

Digital Audio Interface

Digital audio data samples can be transmitted between the TSC2102 and the CPU via the audio data serial port (BCLK, LRCK, DIN) that can be configured to transfer digital data in four different formats: right justified, left justified, I2S, and DSP. The four modes are MSB first and operate with variable word length of 16/20/24/32 bits. The TSC2102 audio data serial port can operate in master or slave mode. The word-select signal (LRCK) and bit clock signal (BCLK) are output in master mode and input in slave mode, and both can be turned off by software power down. The LRCK also is the synchronization signal for DIN and represents the sampling rate of the DAC. All registers, including those pertaining to audio functionality, are only configured via the SPI bus.

● DAC SAMPLING RATE

The audio-control-1 register (Register 00H, Page 2) determines the sampling rates of DAC, which is scaled down from the reference rate (Fsref) of either 44.1 kHz or 48 kHz, which is selectable by bit D13 of control register 06H/Page2. The frequency of the LRCK represents the sampling rate of the DAC. At power up, it is configured as an I2S SLAVE with the DAC operating at Fsref.

● WORD SELECT SIGNALS

The word select signal (LRCK) indicates the channel being transmitted:

- LRCK = 0: left channel for I2S mode
- LRCK = 1: right channel for I2S mode

For other modes, check the timing diagrams below.

● 256–S TRANSFER MODE

In the 256-S mode, the BCLK rate always equals 256 times the LRCK frequency. In the 256-S transfer mode, the combination of the 48-kps sampling rate and left-justified mode is not supported.

● CONTINUOUS TRANSFER MODE

In continuous transfer mode, the BCLK rate always equals two times the word length times the LRCK frequency.

● RIGHT-JUSTIFIED MODE

In right-justified mode, the LSB of the left channel is valid on the rising edge of the BCLK preceding the falling edge of LRCK. Similarly, the LSB of the right channel is valid on the rising edge of the BCLK preceding the rising edge of LRCK.

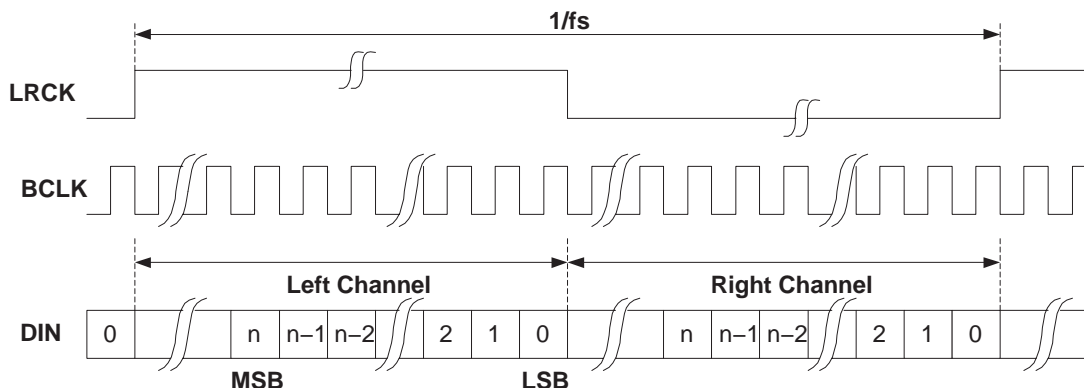


Figure 18. Timing Diagram for Right-Justified Mode

● LEFT-JUSTIFIED MODE

In left-justified mode, the MSB of the right channel is valid on the rising edge of the BCLK following the falling edge of LRCK. Similarly the MSB of the left channel is valid on the rising edge of the BCLK following the rising edge of LRCK.

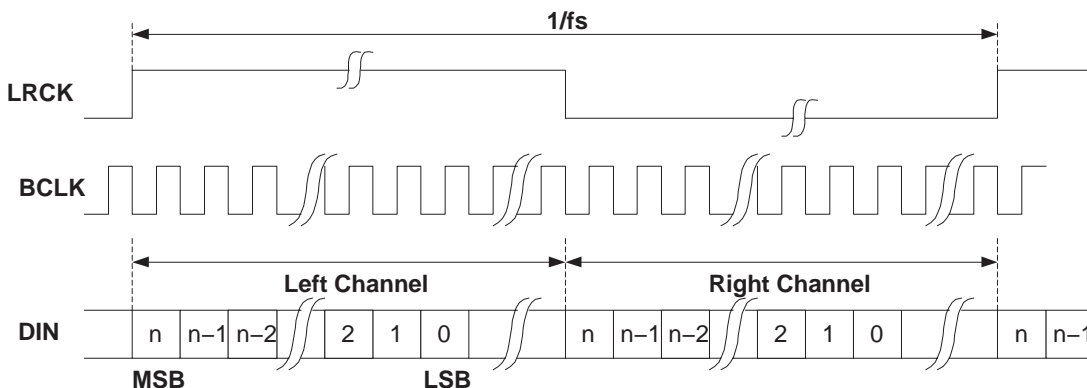


Figure 19. Timing Diagram for Left-Justified Mode

● I2S MODE

In I2S mode, the MSB of the left channel is valid on the second rising edge of the BCLK after the falling edge of LRCK. Similarly, the MSB of the right channel is valid on the second rising edge of the BCLK after the rising edge of LRCK.

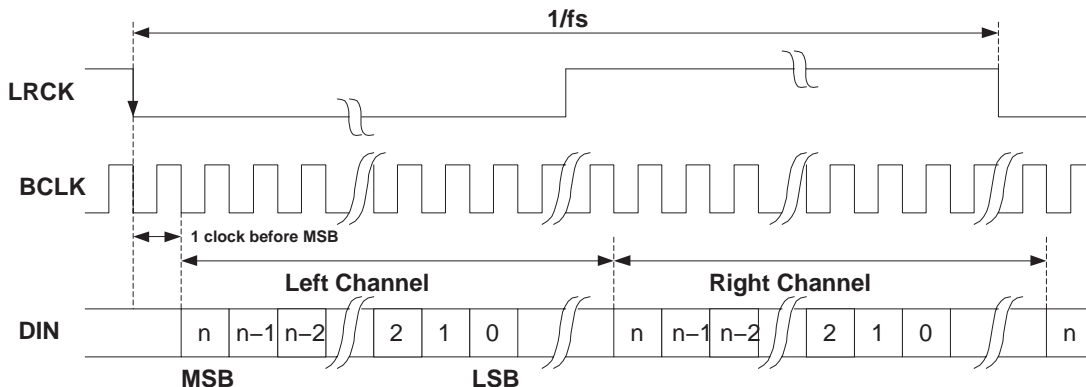


Figure 20. Timing Diagram for I2S Mode

● DSP MODE

In DSP mode, the falling edge of LRCK starts the data transfer with the left channel data first and immediately followed by the right channel data. Each data bit is valid on the falling edge of BCLK.

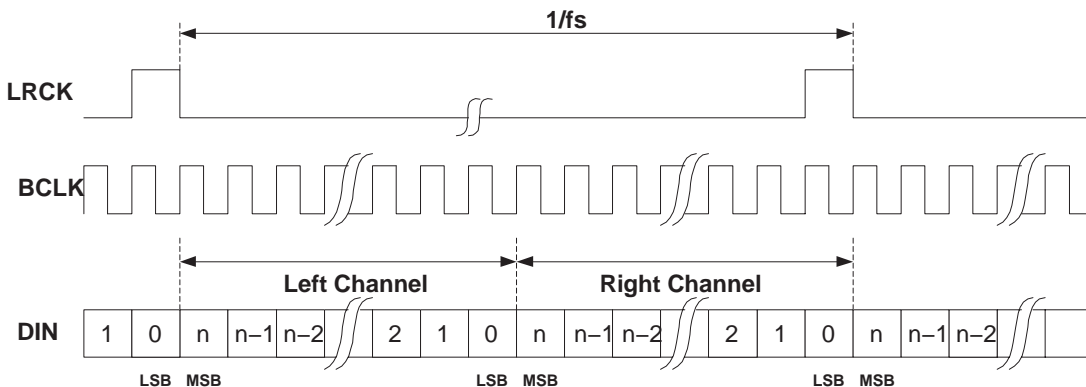


Figure 21. Timing Diagram for DSP Mode

STEREO AUDIO DAC

The TSC2102 includes a stereo audio DAC, which can operate with a maximum sampling rate of 48 kHz and can support all standard audio rates of 8 kHz, 11.025 kHz, 12 kHz, 16kHz, 22.05 kHz, 24 kHz, 32 kHz, 44.1 kHz, and 48 kHz.

When the DAC is operating, the TSC2102 requires an audio MCLK input applied. The user is required to set D13 of control register 06H/Page2 to indicate which Fsref rate is being used. If the DAC is powered up, then the touch screen ADC runs off the MCLK and BCLK, and the internal oscillator is powered down to save power.

Each channel of the stereo audio DAC consists of a digital audio processing block, a digital interpolation filter, digital delta-sigma modulator, and analog reconstruction filter. The DAC is designed to provide enhanced performance at low sample rates through increased oversampling and image filtering, thereby keeping quantization noise generated within the delta-sigma modulator and signal images strongly suppressed within the audio band to beyond 20 kHz. This is realized by keeping the upsampled rate constant at $128 \times \text{Fsref}$ and changing the oversampling ratio as the input sample rate is changed. For Fsref of 48 kHz, the digital delta-sigma modulator always operates at a rate of 6.144 MHz. This ensures that quantization noise generated within the delta-sigma modulator stays low within the frequency band below 20 kHz at all sample rates. Similarly, for Fsref rate of 44.1 kHz, the digital delta-sigma modulator always operates at a rate of 5.6448 MHz.

PLL

The TSC2102 has an on chip PLL to generate the needed internal audio clocks from the clock available in the system. The PLL supports a MCLK varying from 2 MHz to 50 MHz and is register programmable to enable generation of the required sampling rates from a wide range of system clocks.

The DAC sampling rate is given by:

$$\text{DAC_FS} = \text{Fsref}/N$$

where, Fsref is 44.1 kHz or 48 kHz and N = 1, 1.5, 2, 3, 4, 5, 6 are register programmable.

The PLL can be enabled or disabled using register programmability.

- When PLL is disabled

$$\text{Fsref} = \frac{\text{MCLK}}{128 \times Q}$$

$$Q = 2, 3 \dots 17$$

- When PLL is enabled

$$\text{Fsref} = \frac{\text{MCLK} \times K}{2048 \times P}$$

$$P = 1, 2, 3, \dots, 8$$

$$K = J.D$$

$$J = 1, 2, 3, \dots, 64$$

$$D = 0, 1, 2, \dots, 9999$$

where, D is the 4-digit fractional part of K with lagging zeros (e.g. if K = 8.5, then D = 5000 and if K = 8.02, then D = 200).

P, J and D are register programmable.

- When D = 0, the following condition needs to be satisfied

$$2 \text{ MHz} \leq \frac{\text{MCLK}}{P} \leq 20 \text{ MHz}$$

- When D ≠ 0, the following condition needs to be satisfied

$$10 \text{ MHz} \leq \frac{\text{MCLK}}{P} \leq 20 \text{ MHz}$$

Example 1:

For MCLK = 12 MHz and Fsref = 44.1 kHz

$$P = 1, K = 7.5264 \Rightarrow J = 7, D = 5264$$

Example 2:

For MCLK = 12 MHz and Fsref = 48.0 kHz

P = 1, K = 8.192 ⇒ J = 8, D = 1920

Digital Audio Processing

The DAC channel consists of optional filters for de-emphasis and bass, treble, midrange level adjustment, or speaker equalization. The de-emphasis function is only available for sample rates of 32 kHz, 44.1 kHz, and 48 kHz. The transfer function consists of a pole with time constant of 50 μs and a zero with time constant of 15 μs. Frequency response plots are given in the *Audio Codec Filter Frequency Responses* section of this data sheet.

The DAC digital effects processing block also includes a fourth order digital IIR filter with programmable coefficients (one set per channel). The filter is implemented as cascade of two biquad sections with frequency response given by:

$$\left(\frac{N0 + 2 \times N1 \times z^{-1} + N2 \times z^{-2}}{32768 - 2 \times D1 \times z^{-1} - D2 \times z^{-2}} \right) \left(\frac{N3 + 2 \times N4 \times z^{-1} + N5 \times z^{-2}}{32768 - 2 \times D4 \times z^{-1} - D5 \times z^{-2}} \right)$$

The N and D coefficients are fully programmable, and the entire filter can be enabled or bypassed. The coefficients for this filter implement a variety of sound effects with bass boost or treble boost as the most commonly used in portable audio applications. The default N and D coefficients in the part are given by:

N0 = N3 = 27619 D1 = D4 = 32131
N1 = N4 = -27034 D2 = D5 = -31506
N2 = N5 = 26461

and implement a shelving filter with 0-dB gain from dc to approximately 150 Hz, at which point it rolls off to 3-dB attenuation for higher frequency signals, thus giving a 3-dB boost to signals below 150 Hz. The N and D coefficients are represented by 16-bit twos complement numbers with values ranging from 32767 to -32768. Frequency response plots are given in the *Audio Codec Filter Frequency Responses* section of this data sheet.

Interpolation Filter

The interpolation filter upsamples the output of the digital audio processing block by the required oversampling ratio. It provides a linear phase output with a group delay of 21/Fs.

In addition, the digital interpolation filter provides enhanced image filtering to reduce signal images caused by the upsampling process that are below 20 kHz. For example, upsampling an 8-kHz signal produces signal images at multiples of 8 kHz, i.e., 8 kHz, 16 kHz, 24 kHz, etc. The images at 8 kHz and 16 kHz are below 20 kHz and still audible to the listener, therefore, they must be filtered heavily to maintain a good quality output. The interpolation filter is designed to maintain at least 65-dB rejection of images that land below 7.455 Fs. Passband ripple for all sample-rate cases (from 20 Hz to 0.45 Fs) is ±0.06 dB maximum

Delta-Sigma DAC

The audio digital-to-analog converter incorporates a third order multibit delta-sigma modulator with 768/512/384/256/192/128 times oversampling followed by an analog reconstruction filter. The DAC provides high-resolution, low-noise performance, using oversampling and noise shaping techniques. The analog reconstruction filter design consists of a 6 tap analog FIR filter followed by a continuous time RC filter. The analog FIR operates at 6.144 MHz (128x48 kHz, for Fsref of 48 kHz) or at 5.6448 MHz (128x44.1 kHz, for Fsref of 44.1 kHz). The DAC analog performance can be degraded by excessive clock jitter on the MCLK input. Therefore, care must be taken to keep jitter on this clock to a minimum.

DAC Digital Volume Control

The DAC has a digital volume control block, which implements a programmable gain. The volume level can be varied from 0dB to –63.5 dB in 0.5 dB steps, in addition to a mute bit, independently for each channel. The volume level of both channels can also be changed simultaneously by the master volume control. The gain is implemented with a soft-stepping algorithm, which only changes the actual volume by one step per input sample, either up or down, until the desired volume is reached. The rate of soft-stepping can be slowed to one step per two input samples through D1 of control register 04H/Page2.

Because of soft-stepping, the host does not know when the DAC has actually been muted. This may be important if the host wishes to mute the DAC before making a significant change, such as changing sample rates. In order to help with this situation, the part provides a flag back to the host via a read-only register bit (D2–D3 of control register 04H/Page2) that alerts the host when the part has completed the soft-stepping and the actual volume has reached the desired volume level.

The TSC2102 also includes functionality to detect when the user switches on or off the de-emphasis or bass-boost functions, then first (1) soft-mute the DAC volume control, (2) change the operation of the digital effects processing, and (3) soft-unmute the TSC2102. This avoids any possible pop/clicks in the audio output due to instantaneous changes in the filtering. A similar algorithm is used when first powering up or down the DAC. The circuit begins operation at power up with the volume control muted, then soft-steps it up to the desired volume level. At power down, the logic first soft-steps the volume down to a mute level, then powers down the circuitry.

Headphone Driver

The TSC2102 features a stereo headphone driver that can deliver 25 mW per channel at 3.3-V supply, into 16-Ω load. The headphones can be connected in a single-ended configuration using ac-coupling capacitors, or the capacitors can be removed and virtual ground (VGND) connection powered. These two configurations are shown in Figure 22. If the headphone amplifiers are not needed, such as when the external audio amplifier is used, then the headphone drivers can be bypassed to save power using register programming. When bypassed, the HPR and HPL outputs act as line level outputs capable of driving a load of 10 kΩ minimum.

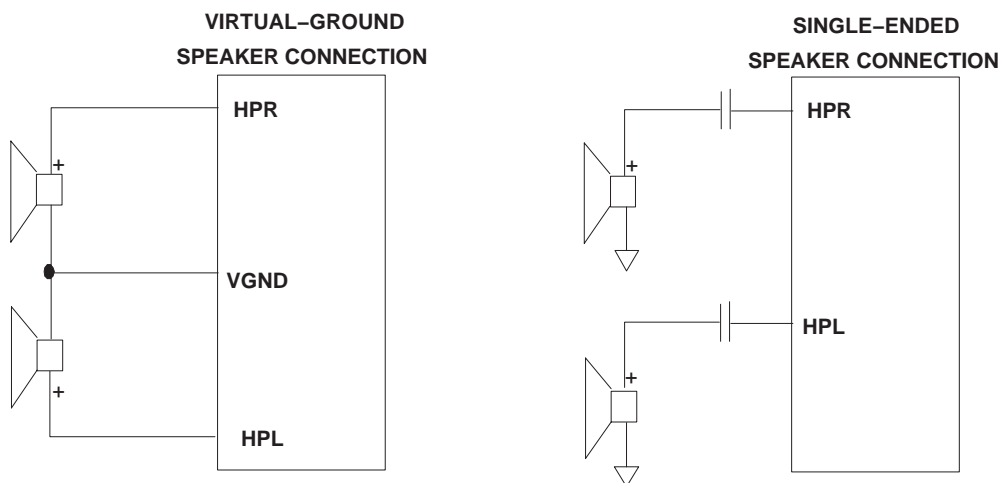


Figure 22. Connection Diagram for DAC Outputs

KEYCLICK

A special circuit has also been included for inserting a square-wave signal into the analog output signal path based on register control. This functionality is intended for generating keyclick sounds for user feedback. Register 04H/Page2 contains bits that control the amplitude, frequency, and duration of the square-wave signal. The frequency of the signal can be varied from 62.5 Hz to 8 kHz and its duration can be programmed from 2 periods to 32 periods. Whenever this register is written, the square wave is generated and coupled into the audio output, going to both the outputs. The keyclick enable bit D15 of control register 04H/Page2 is reset after the duration of keyclick is played out. This capability is available even when the DAC is powered down.

SPI DIGITAL INTERFACE

All TSC2102 control registers are programmed through a standard SPI bus. The SPI allows full-duplex, synchronous, serial communication between a host processor (the master) and peripheral devices (slaves). The SPI master generates the synchronizing clock and initiates transmissions. The SPI slave devices depend on a master to start and synchronize transmissions.

A transmission begins when initiated by a master SPI. The byte from the master SPI begins shifting in on the slave SPIDIN (MOSI) pin under the control of the master serial clock. As the byte shifts in on the SPIDIN pin, a byte shifts out on the SPIDOUT (MISO) pin to the master shift register.

The idle state of the serial clock for the TSC2102 is low, which corresponds to a clock polarity setting of 0 (typical microprocessor SPI control bit CPOL = 0). The TSC2102 interface is designed so that with a clock phase bit setting of 1 (typical microprocessor SPI control bit CPHA = 1), the master begins driving its MOSI pin and the slave begins driving its SPIDOUT pin on the first serial clock edge. The \overline{SS} pin can remain low between transmissions; however, the TSC2102 only interprets command words which are transmitted after the falling edge of \overline{SS} .

TSC2102 COMMUNICATION PROTOCOL

Register Programming

The TSC2102 is entirely controlled by registers. Reading and writing these registers is controlled by an SPI master and accomplished by the use of a 16-bit command, which is sent prior to the data for that register. The command is constructed as shown in Figure 23.

The command word begins with a R/W bit, which specifies the direction of data flow on the SPI serial bus. The following 4 bits specify the page of memory this command is directed to, as shown in Table 2. The next six bits specify the register address on that page of memory to which the data is directed. The last five bits are reserved for future use and should be written only with zeros.

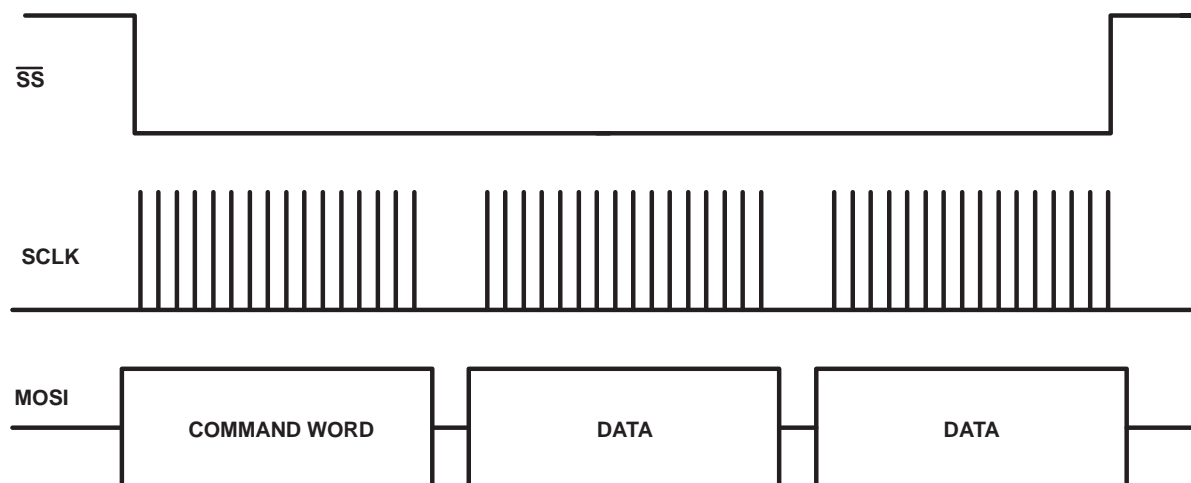
Table 2. Page Addressing

| PG3 | PG2 | PG1 | PG0 | PAGE ADDRESSED |
|-----|-----|-----|-----|----------------|
| 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 1 | 0 | 2 |
| 0 | 0 | 1 | 1 | Reserved |
| 0 | 1 | 0 | 0 | Reserved |
| 0 | 1 | 0 | 1 | Reserved |
| 0 | 1 | 1 | 0 | Reserved |
| 0 | 1 | 1 | 1 | Reserved |
| 1 | 0 | 0 | 0 | Reserved |
| 1 | 0 | 0 | 1 | Reserved |
| 1 | 0 | 1 | 0 | Reserved |
| 1 | 0 | 1 | 1 | Reserved |
| 1 | 1 | 0 | 0 | Reserved |
| 1 | 1 | 0 | 1 | Reserved |
| 1 | 1 | 1 | 0 | Reserved |
| 1 | 1 | 1 | 1 | Reserved |

To read all the first page of memory, for example, the host processor must send the TSC2102 the command 0x8000 – this specifies a read operation beginning at page 0, address 0. The processor can then start clocking data out of the TSC2102. The TSC2102 automatically increments its address pointer to the end of the page; if the host processor continues clocking data out past the end of a page, the TSC2102 sends back the value 0xFFFF.

Likewise, writing to page 1 of memory consists of the processor writing the command 0x0800, which specifies a write operation, with PG0 set to 1, and all the ADDR bits set to 0. This results in the address pointer pointing at the first location in memory on Page 1. See the section on the TSC2102 memory map for details of register locations

| BIT 15 MSB | BIT 14 | BIT 13 | BIT 12 | BIT 11 | BIT 10 | BIT 9 | BIT 8 | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 LSB |
|---------------|--------|--------|--------|--------|--------|-------|-------|-------|-------|-------|-------|-------|-------|-------|--------------|
| R/W* | PG3 | PG2 | PG1 | PG0 | ADDR5 | ADDR4 | ADDR3 | ADDR2 | ADDR1 | ADDR0 | 0 | 0 | 0 | 0 | 0 |

Figure 23. TSC2102 Command Word**Figure 24. Write Operation for TSC2102 SPI Interface**

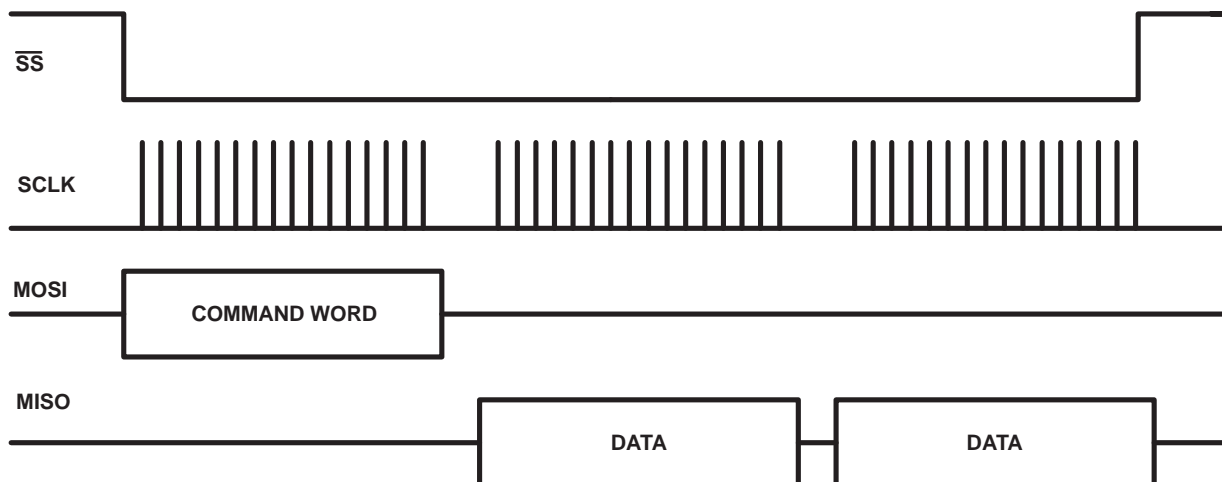


Figure 25. Read Operation for TSC2102 SPI Interface

TSC2102 MEMORY MAP

The TSC2102 has several 16-bit registers, which allow control of the device as well as providing a location for results from the TSC2102 to be stored until read by the host microprocessor. These registers are separated into three pages of memory in the TSC2102: a data page (Page 0) and control pages (Page 1 and Page 2). The memory map is shown in Table 3.

Table 3. Memory Map

| Page 0: Touch Screen Data Registers | | Page 1: Touch Screen Control Registers | | Page 2: Audio Control Registers | |
|-------------------------------------|----------|----------------------------------------|---------------|---------------------------------|--------------------------------------|
| ADDR | REGISTER | ADDR | REGISTER | ADDR | REGISTER |
| 00 | X | 00 | TSC ADC | 00 | Audio Control 1 |
| 01 | Y | 01 | Status | 01 | Reserved |
| 02 | Z1 | 02 | Reserved | 02 | DAC Volume Control |
| 03 | Z2 | 03 | Reference | 03 | Reserved |
| 04 | Reserved | 04 | Reset | 04 | Audio Control 2 |
| 05 | BAT1 | 05 | Configuration | 05 | Stereo DAC Power Control |
| 06 | BAT2 | 06 | Reserved | 06 | Audio Control 3 |
| 07 | AUX | 07 | Reserved | 07 | Audio Bass–Boost Filter Coefficients |
| 08 | Reserved | 08 | Reserved | 08 | Audio Bass–Boost Filter Coefficients |
| 09 | TEMP1 | 09 | Reserved | 09 | Audio Bass–Boost Filter Coefficients |
| 0A | TEMP2 | 0A | Reserved | 0A | Audio Bass–Boost Filter Coefficients |
| 0B | Reserved | 0B | Reserved | 0B | Audio Bass–Boost Filter Coefficients |
| 0C | Reserved | 0C | Reserved | 0C | Audio Bass–Boost Filter Coefficients |
| 0D | Reserved | 0D | Reserved | 0D | Audio Bass–Boost Filter Coefficients |
| 0E | Reserved | 0E | Reserved | 0E | Audio Bass–Boost Filter Coefficients |
| 0F | Reserved | 0F | Reserved | 0F | Audio Bass–Boost Filter Coefficients |
| 10 | Reserved | 10 | Reserved | 10 | Audio Bass–Boost Filter Coefficients |
| 11 | Reserved | 11 | Reserved | 11 | Audio Bass–Boost Filter Coefficients |
| 12 | Reserved | 12 | Reserved | 12 | Audio Bass–Boost Filter Coefficients |
| 13 | Reserved | 13 | Reserved | 13 | Audio Bass–Boost Filter Coefficients |
| 14 | Reserved | 14 | Reserved | 14 | Audio Bass–Boost Filter Coefficients |
| 15 | Reserved | 15 | Reserved | 15 | Audio Bass–Boost Filter Coefficients |
| 16 | Reserved | 16 | Reserved | 16 | Audio Bass–Boost Filter Coefficients |
| 17 | Reserved | 17 | Reserved | 17 | Audio Bass–Boost Filter Coefficients |
| 18 | Reserved | 18 | Reserved | 18 | Audio Bass–Boost Filter Coefficients |
| 19 | Reserved | 19 | Reserved | 19 | Audio Bass–Boost Filter Coefficients |
| 1A | Reserved | 1A | Reserved | 1A | Audio Bass–Boost Filter Coefficients |
| 1B | Reserved | 1B | Reserved | 1B | PLL Programmability |
| 1C | Reserved | 1C | Reserved | 1C | PLL Programmability |
| 1D | Reserved | 1D | Reserved | 1D | Audio Control 4 |
| 1E | Reserved | 1E | Reserved | 1E | Reserved |
| 1F | Reserved | 1F | Reserved | 1F | Reserved |

TSC2102 CONTROL REGISTERS

This section describes each of the registers shown in the memory map of Table 3. The registers are grouped according to the function they control. In the TSC2102, bits in control registers can refer to slightly different functions depending upon whether you are reading the register or writing to the register.

TSC2102 Data Registers (Page 0)

The data registers of the TSC2102 hold data results from conversion performed by the touch screen ADC. All of these registers default to 0000H upon reset. These registers are *read only*.

X, Y, Z1, Z2, BAT1, BAT2, AUX, TEMP1 and TEMP2 Registers

The results of all A/D conversions are placed in the appropriate data register. The data format of the result word, R, of these registers is right-justified, as follows:

| BIT 15 MSB | BIT 14 | BIT 13 | BIT 12 | BIT 11 | BIT 10 | BIT 9 | BIT 8 | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 LSB |
|---------------|--------|--------|--------|------------|--------|-------|-------|-------|-------|-------|-------|-------|-------|-------|--------------|
| 0 | 0 | 0 | 0 | R11 MSB | R10 | R9 | R8 | R7 | R6 | R5 | R4 | R3 | R2 | R1 | R0 LSB |

PAGE 1 CONTROL REGISTER MAP

REGISTER 00H: Touch Screen ADC Control

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|-----|-------|----------------|-------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15 | PSTCM | R/W | 0(for read status) 0(for write status) | Pen Status/Control Mode. READ 0 => There is no screen touch (default) 1 => The pen is down WRITE 0 => Host controlled touch screen conversions(default). 1=> TSC2102 controlled touch screen conversions. |
| D14 | ADST | R/W | 1(for read status) 0(for write status) | A/D Status. READ 0 => ADC is busy 1 => ADC is not busy (default) WRITE 0 => Normal mode. (default) 1 => Stop conversion and power down. Power down happens immediately |

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION | | | | | | | | | | | | | | | |
|--------|-----------------|-----------------|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|-------------|---------------|-------|------------|------------|-------|----------------|----------------|-------|----------------|----------------|-------|-----------------|-----------------|
| D13–10 | ADSCM | R/W | 0000 | A/D Scan Mode. 0000 => No scan 0001 => Touch screen scan function: X and Y coordinates are converted and the results returned to X and Y data registers. Scan continues until either the pen is lifted or a stop bit is sent. 0010 => Touch screen scan function: X, Y, Z1 and Z2 coordinates are converted and the results returned to X, Y, Z1 and Z2 data registers. Scan continues until either the pen is lifted or a stop bit is sent. 0011 => Touch screen scan function: X coordinate is converted and the results returned to X data register. 0100 => Touch screen scan function: Y coordinate is converted and the results returned to Y data register. 0101 => Touch screen scan function: Z1 and Z2 coordinates are converted and the results returned to Z1 and Z2 data registers. 0110 => BAT1 input is converted and the result is returned to the BAT1 data register. 0111 => BAT2 input is converted and the result is returned to the BAT2 data register. 1000 => AUX input is converted and the result is returned to the AUX data register. 1001 => Scan function :AUX input is converted and the result is returned to the AUX data register. Scan continues until stop bit is sent. 1010 => TEMP1 is converted and the result is returned to the TEMP1 data register. 1011 => Port scan function: BAT1, BAT2 and AUX inputs are measured and the results returned to the appropriate data registers. 1100 => TEMP2 is converted and the result is returned to the TEMP2 data register. 1101 => Turn on X+, X– drivers 1110 => Turn on Y+, Y– drivers 1111 => Turn on Y+, X– drivers | | | | | | | | | | | | | | | |
| D9–D8 | RESOL | R/W | 00 | Resolution Control. The A/D converter resolution is specified with these bits. 00 => 12–bit resolution 01 => 8–bit resolution 10 => 10–bit resolution 11 => 12–bit resolution | | | | | | | | | | | | | | | |
| D7–D6 | ADAVG | R/W | 00 | Converter Averaging Control. These two bits allow you to specify the number of averages the converter performs selected by bit D0, which selects either mean filter or median filter. <table><tr><td></td><td>Mean Filter</td><td>Median filter</td></tr><tr><td>00 =></td><td>No average</td><td>No average</td></tr><tr><td>01 =></td><td>4–data average</td><td>5–data average</td></tr><tr><td>10 =></td><td>8–data average</td><td>9–data average</td></tr><tr><td>11 =></td><td>16–data average</td><td>15–data average</td></tr></table> | | Mean Filter | Median filter | 00 => | No average | No average | 01 => | 4–data average | 5–data average | 10 => | 8–data average | 9–data average | 11 => | 16–data average | 15–data average |
| | Mean Filter | Median filter | | | | | | | | | | | | | | | | | |
| 00 => | No average | No average | | | | | | | | | | | | | | | | | |
| 01 => | 4–data average | 5–data average | | | | | | | | | | | | | | | | | |
| 10 => | 8–data average | 9–data average | | | | | | | | | | | | | | | | | |
| 11 => | 16–data average | 15–data average | | | | | | | | | | | | | | | | | |
| D5–D4 | ADCR | R/W | 00 | Conversion Rate Control. These two bits specify the internal clock rate which the A/D converter uses to perform a single conversion. These bits are the same whether reading or writing. $t_{\text{conv}} = \frac{N + 4}{f_{\text{INTCLK}}}$ <p>where f_{INTCLK} is the internal clock frequency. For example, with 12-bit resolution and a 2-MHz internal clock frequency, the conversion time is 8.0 μs. This yields an effective throughput rate of 125 kHz.</p> <p>00 => 8-MHz internal clock rate (use for 8-bit resolution only) 01 => 4-MHz internal clock rate (use for 8-bit/10-bit resolution only) 10 => 2-MHz internal clock rate 11 => 1-MHz internal clock rate</p> | | | | | | | | | | | | | | | |

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|-------|-------|----------------|----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D3–D1 | PVSTC | R/W | 000 | Panel Voltage Stabilization Time Control. These bits allow you to specify a delay time from the time the touch screen drivers are enabled to the time the voltage is sampled and a conversion is started. This allows the user to adjust for the settling of the individual touch panel and external capacitances. 000 => 0-μs stabilization time 001 => 100-μs stabilization time 010 => 500-μs stabilization time 011 => 1-ms stabilization time 100 => 5-ms stabilization time 101 => 10-ms stabilization time 110 => 50-ms stabilization time 111 => 100-ms stabilization time |
| D0 | AVGFS | R/W | 0 | Average Filter select 0 => Mean filter 1 => Median filter |

REGISTER 01H: Status Register

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|---------|---------|----------------|----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15–D14 | PINTDAV | R/W | 10 | Pen Interrupt or Data Available. These two bits program the function of the <u>PINTDAV</u> pin. 00 => Acts as PEN interrupt (active low) only. When <u>PEN</u> touch is detected, <u>PINTDAV</u> goes low. 01 => Acts as data available (active low) only. The <u>PINTDAV</u> goes low as soon as one set of ADC conversion(s) is completed. For scan mode, <u>PINTDAV</u> remains low as long as all the appropriate registers have not been read out. 10 => Acts as both <u>PEN</u> interrupt and data available. When <u>PEN</u> touch is detected, <u>PINTDAV</u> goes low. <u>PINTDAV</u> goes high once all the selected conversions are over. 11 => Same as 10 Note: See the section <i>Conversion Time Calculation for the TSC2102</i> in this data sheet for timing diagrams and conversion time calculations. |
| D13 | PWRDN | R | 0 | TSC–ADC Power down status 0 => TSC–ADC is active 1 => TSC–ADC stops conversion and powers down |
| D12 | HCTLM | R | 0 | Host Controlled Mode Status 0 => Host controlled mode 1 => Self (TSC2102) controlled mode |
| D11 | DAVAIL | R | 0 | Data Available Status 0 => No data available. 1 => Data is available(i.e one set of conversion is done) Note:– This bit gets cleared only after all the converted data have been completely read out. |
| D10 | XSTAT | R | 0 | X Data Register Status 0 => No new data is available in X–data register 1 => New data for X–coordinate is available in register Note: This bit gets cleared only after the converted data of X coordinate has been completely read out of the register. |
| D9 | YSTAT | R | 0 | Y Data Register Status 0 => No new data is available in Y–data register 1 => New data for Y–coordinate is available in register Note: This bit gets cleared only after the converted data of Y coordinate has been completely read out of the register. |
| D8 | Z1STAT | R | 0 | Z1 Data Register Status 0 => No new data is available in Z1–data register 1 => New data is available in Z1–data register Note: This bit gets cleared only after the converted data of Z1 coordinate has been completely read out of the register. |

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|-----|--------|----------------|----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D7 | Z2STAT | R | 0 | Z2 Data Register Status 0 => No new data is available in Z2–data register 1 => New data is available in Z2–data register Note: This bit gets cleared only after the converted data of Z2 coordinate has been completely read out of the register. |
| D6 | B1STAT | R | 0 | BAT1 Data Register Status 0 => No new data is available in BAT1–data register 1 => New data is available in BAT1–data register Note: This bit gets cleared only after the converted data of BAT1 has been completely read out of the register. |
| D5 | B2STAT | R | 0 | BAT2 Data Register Status 0 => No new data is available in BAT2–data register 1 => New data is available in BAT2–data register Note: This bit gets cleared only after the converted data of BAT2 has been completely read out of the register. |
| D4 | AXSTAT | R | 0 | AUX Data Register Status 0 => No new data is available in AUX–data register 1 => New data is available in AUX–data register Note: This bit gets cleared only after the converted data of AUX has been completely read out of the register. |
| D3 | | R | 0 | Reserved |
| D2 | T1STAT | R | 0 | TEMP1 Data Register Status 0 => No new data is available in TEMP1–data register 1 => New data is available in TEMP1–data register Note: This bit gets cleared only after the converted data of TEMP1 has been completely read out of the register. |
| D1 | T2STAT | R | 0 | TEMP2 Data Register Status 0 => No new data is available in TEMP2–data register 1 => New data is available in TEMP2–data register Note: This bit gets cleared only after the converted data of TEMP2 has been completely read out of the register. |
| D0 | | R | 0 | Reserved |

REGISTER 02H: Reserved

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|--------|------|----------------|----------------|----------|
| D15–D0 | | R | FFFFH | Reserved |

REGISTER 03H: Reference Control

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|--------|--------|----------------|----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15–D5 | | R | 000H | Reserved |
| D4 | VREFM | R/W | 0 | Voltage Reference Mode. This bit configures the VREF pin as either external reference or internal reference. 0 => External reference 1 => Internal reference |
| D3–D2 | RPWUDL | R/W | 00 | Reference Power Up Delay. These bits allow for a delay time for measurements to be made after the reference powers up, thereby assuring that the reference has settled 00 => 0 μ s 01 => 100 μ s 10 => 500 μ s 11 => 1000 μ s Note: This is valid only when the device is programmed for internal reference and Bit D1 = 1, i.e., reference is powered down between the conversions if not required. |

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|-----|-------|----------------|----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | RPWDN | R/W | 1 | Reference Power Down. This bit controls the power down of the internal reference voltage. 0 => Powered up at all times. 1 => Powered down between conversions. Note: when D4 = 0, i.e. device is in external reference mode, then the internal reference is powered down always. |
| D0 | IREFV | R/W | 0 | Internal Reference Voltage. This bit selects the internal voltage reference level for the TSC ADC. 0 => VREF = 1.25 V 1 => VREF = 2.50 V |

REGISTER 04H: Reset Control

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|--------|-------|----------------|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15–D0 | RSALL | R/W | FFFFH | Reset All. Writing the code 0xBB00, as shown below, to this register causes the TSC2102 to reset all its registers to their default, power-up values. 1011101100000000 => Reset all registers Others => Do not write other sequences to this register. |

REGISTER 05H: Configuration Control

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|--------|--------|----------------|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15–D6 | | R | 000H | Reserved. Write only zeros to these bits. |
| D5–D3 | PRECTM | R/W | 000 | Precharge Time. These bits set the amount of time allowed for precharging any pin capacitance on the touch screen prior to sensing if a screen touch is happening. 000 => 20 μ s 001 => 84 μ s 010 => 276 μ s 011 => 340 μ s 100 => 1.044 ms 101 => 1.108 ms 110 => 1.300 ms 111 => 1.364 ms |
| D2–D0 | RPWUDL | R/W | 000 | Sense Time. These bits set the amount of time the TSC2102 waits to sense whether the screen is being touched, when converting a coordinate value. 000 => 32 μ s 001 => 96 μ s 010 => 544 μ s 011 => 608 μ s 100 => 2.080 ms 101 => 2.144 ms 110 => 2.592 ms 111 => 2.656 ms |

PAGE 2 CONTROL REGISTER MAP**REGISTER 00H: Audio Control 1**

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|---------|-------|----------------|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15–D12 | | R | 0000 | Reserved. Write only 0000 to this location. |
| D11–D10 | WLEN | R/W | 00 | Codec Word Length 00 => Word length = 16 bit 01 => Word length = 20 bit 10 => Word length = 24 bit 11 => Word length = 32 bit |
| D9–D8 | DATFM | R/W | 00 | Digital Data Format 00 => I2S mode 01 => DSP mode 10 => Right justified 11 => Left justified |
| D7–D6 | | R | 00 | Reserved. Write only 00 to this location. |
| D5–D0 | DACFS | R/W | 000 | DAC Sampling Rate 000000 => DAC FS = Fsref/1 001001 => DAC FS = Fsref/(1.5) 010010 => DAC FS = Fsref/2 011011 => DAC FS = Fsref/3 100100 => DAC FS = Fsref/4 101101 => DAC FS = Fsref/5 110110 => DAC FS = Fsref/6 111111 => DAC FS = Fsref/6 others => Not allowed Note: Fsref is either 48 kHz or 44.1 kHz |

REGISTER 01H: Reserved

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|--------|------|----------------|----------------|----------------------------------------------|
| D15–D0 | | R | FF00H | Reserved. Write only FF00H to this location. |

REGISTER 02H: DAC Volume Control

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|--------|-------|----------------|----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15 | DALMU | R/W | 1 | DAC Left Channel Mute 1 => DAC left channel muted 0 => DAC left channel not muted |
| D14–D8 | DALVL | R/W | 111111 | DAC Left Channel Volume Control 111111 => DAC left channel Vol = 0 dB 0000001 => DAC left channel Vol = –0.5 dB 0000010 => DAC left channel Vol = –1.0 dB 1111101 => DAC left channel Vol = –62.5 dB 1111110 => DAC left channel Vol = –63.0 dB 0000000 => DAC left channel Vol = –63.5 dB |
| D7 | DARMU | R/W | 1 | DAC Right Channel Mute 1 => DAC right channel muted 0 => DAC right channel not muted |
| D6–D0 | DARVL | R/W | 111111 | DAC Right Channel Volume Control 111111 => DAC right channel Vol = 0 dB 0000001 => DAC right channel Vol = –0.5 dB 0000010 => DAC right channel Vol = –1.0 dB 1111101 => DAC right channel Vol = –62.5 dB 1111110 => DAC right channel Vol = –63.0 dB 0000000 => DAC right channel Vol = –63.5 dB |

REGISTER 03H: Reserved

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|--------|------|----------------|------------------|----------------------------------------------|
| D15–D0 | | R | 1000101100000000 | Reserved. Write only 8B00H to this location. |

REGISTER 04H: Audio Control 2

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|---------|--------|----------------|----------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15 | KCLLEN | R/W | 0 | Keyclick Enable 0 => Keyclick disabled 1 => Keyclick enabled Note: This bit is automatically cleared after giving out the keyclick signal length equal to the programmed value. |
| D14–D12 | KCLAC | R/W | 100 | Keyclick Amplitude Control 000 => Lowest amplitude 100 => Medium amplitude 111 => Highest amplitude |
| D11 | | R | 0 | Reserved. Write only 0 to this location. |
| D10–D8 | KCLFRQ | R/W | 100 | Keyclick Frequency 000 => 62.5Hz 001 => 125Hz 010 => 250Hz 011 => 500Hz 100 => 1kHz 101 => 2kHz 110 => 4kHz 111 => 8kHz |
| D7–D4 | KCLLN | R/W | 0001 | Keyclick Length 0000 => 2 periods key click 0001 => 4 periods key click 0010 => 6 periods key click 0011 => 8 periods key click all other values => 32 periods key click |
| D3 | DLGAF | R | 0 | DAC Left Channel PGA Flag (Read Only) 0 => Gain applied != PGA register setting 1 => Gain applied = PGA register setting. Note: This flag indicates when the soft-stepping for DAC left channel is completed |
| D2 | DRGAF | R | 0 | DAC Right Channel PGA Flag (Read Only) 0 => Gain applied != PGA register setting 1 => Gain applied = PGA register setting. Note: This flag indicates when the soft-stepping for DAC right channel is completed |
| D1 | DASTC | R/W | 0 | DAC Channel PGA Soft-Stepping Control 0 => 0.5dB change every LRCK 1 => 0.5dB change every 2 LRCK |
| D0 | | R | 0 | Reserved. Write only 0 to this location. |

REGISTER 05H: Stereo DAC Power Control

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|---------|--------|----------------|----------------|------------------------------------------------------------------------------------------------|
| D15 | PWDNC | R/W | 1 | Codec Power-Down Control 0 => Codec powered up 1 => Codec powered down |
| D14–D13 | | R | 01 | Reserved. Write only 01 to this location. |
| D12 | DAODRC | R/W | 0 | DAC Output Driver Control 0 => Headphone driver bypassed 1 => Headphone driver enabled |
| D11 | | R | 1 | Reserved. Write only 1 to this location. |
| D10 | DAPWDN | R/W | 1 | DAC Power-Down Control 0 => Power up the DAC 1 => Power down the DAC |
| D9 | | R | 1 | Reserved. Write only 1 to this location. |
| D8 | VGPWDN | R/W | 1 | Driver Virtual Ground Power Down 0 => Power up the VGND amp 1 => Power down the VGND amp |
| D7 | | R | 1 | Reserved. Write only 1 to this location. |
| D6 | DAPWDF | R | 1 | DAC Power-Down Flag 0 => DAC power down is not complete 1 => DAC power down is complete |
| D5–D2 | | R | 1000 | Reserved. Write only 1000 to this location. |
| D1 | BASSBC | R/W | 0 | Bass Boost Control 0 => Disable bass boost filter 1 => Enable bass boost filter |
| D0 | DEEMPF | R/W | 0 | De–Emphasis Filter Enable 0 => Disable de-emphasis filter 1 => Enable de-emphasis filter |

REGISTER 06H: Audio Control 3

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|---------|--------|----------------|----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15–D14 | DMSVOL | R/W | 00 | DAC Channel Master Volume Control 00 => Left channel and right channel have independent volume controls. 01 => Left channel volume control is the programmed value of the right channel volume control. 10 => Right channel volume control is the programmed value of the left channel volume control. 11 => same as 00 |
| D13 | REFFS | R/W | 0 | Reference Sampling Rate 0 => Fsref = 48.0kHz 1 => Fsref = 44.1kHz |
| D12 | DAXFM | R/W | 0 | Master Transfer Mode 0 => Continuous data transfer mode 1 => 256–s data transfer mode |
| D11 | SLVMS | R/W | 0 | Audio Master Slave Selection 0 => TSC2102 is slave DAC 1 => TSC2102 is master DAC |
| D10–D8 | | R | 000 | Reserved. Write only 000 to this location. |
| D7 | DALOVF | R | 0 | DAC Left Channel Overflow Flag (Read Only) 0 => DAC left channel data is within saturation limits 1 => DAC left channel data has exceeded saturation limits Note : Once this flag is set to 1, it gets cleared only when user reads this register. |
| D6 | DAROVF | R | 0 | DAC Right Channel Overflow Flag (Read Only) RESET VAL = 0 0 => DAC right channel data is within saturation limits 1 => DAC right channel data has exceeded saturation limits Note : Once this flag is set to 1, it is cleared only when user reads this register |
| D5–D3 | | R | 000 | Reserved. Write only 000 to this location. |
| D2–D0 | REVID | R | 001 | Revision ID. This field represents the silicon revision and should always read 001. |

REGISTER 07H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_N0 | R/W | 27619 | Left channel bass-boost coefficient N0. |

REGISTER 08H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_N1 | R/W | –27034 | Left channel bass-boost coefficient N1. |

REGISTER 09H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_N2 | R/W | 26461 | Left channel bass-boost coefficient N2. |

REGISTER 0AH: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_N3 | R/W | 27619 | Left channel bass-boost coefficient N3. |

REGISTER 0BH: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_N4 | R/W | –27034 | Left channel bass-boost coefficient N4. |

REGISTER 0CH: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_N5 | R/W | 26461 | Left channel bass-boost coefficient N5. |

REGISTER 0DH: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_D1 | R/W | 32131 | Left channel bass-boost coefficient D1. |

REGISTER 0EH: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_D2 | R/W | –31506 | Left channel bass-boost coefficient D2. |

REGISTER 0FH: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_D4 | R/W | 32131 | Left channel bass-boost coefficient D4. |

REGISTER 10H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|-----------------------------------------|
| D15–D0 | L_D5 | R/W | –31506 | Left channel bass-boost coefficient D5. |

REGISTER 11H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_N0 | R/W | 27619 | Right channel bass-boost coefficient N0. |

REGISTER 12H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_N1 | R/W | –27034 | Right channel bass-boost coefficient N1. |

REGISTER 13H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_N2 | R/W | 26461 | Right channel bass-boost coefficient N2. |

REGISTER 14H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_N3 | R/W | 27619 | Right channel bass-boost coefficient N3. |

REGISTER 15H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_N4 | R/W | –27034 | Right channel bass-boost coefficient N4. |

REGISTER 16H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_N5 | R/W | 26461 | Right channel bass-boost coefficient N5. |

REGISTER 17H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_D1 | R/W | 32131 | Right channel bass-boost coefficient D1. |

REGISTER 18H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_D2 | R/W | –31506 | Right channel bass-boost coefficient D2. |

REGISTER 19H: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_D4 | R/W | 32131 | Right channel bass-boost coefficient D4. |

REGISTER 1AH: Audio Bass Boost Coefficients

| BIT | NAME | READ/ WRITE | RESET VALUE (IN DECIMAL) | FUNCTION |
|--------|------|----------------|-----------------------------|------------------------------------------|
| D15–D0 | R_D5 | R/W | –31506 | Right channel bass-boost coefficient D5. |

REGISTER 1BH: PLL Programmability

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|---------|----------|----------------|-------------|-------------------------------------------------------------------------------------------------------------------|
| D15 | PLEN | R/W | 0 | PLL Enable 0 => Disable PLL 1 => Enable PLL |
| D14–D11 | QVAL | R/W | 0010 | Q value. Valid only if D15 = 0. 0000 => 16 0001 => 1 0010 => 2 1110 => 14 1111 => 15 |
| D10–D8 | PVAL | R/W | 000 | P value. Valid only if D15 = 1. 000=> 8 001=> 1 010 => 2 110 => 6 111 => 7 |
| D7–D2 | JVAL | R/W | 000001 | J value. Valid only if D15 = 1. 000001 => 1 000010 => 2 111101 => 61 111110 => 62 111111 => 63 |
| D1–D0 | Reserved | R | 00 | Reserved. Write only 00 to this location. |

REGISTER 1CH: PLL Programmability

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|--------|----------|----------------|----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D15–D2 | DVAL | R/W | 0 (in decimal) | D value. Used when PLL is enabled. D value is valid from 0000 to 9999 in decimal. Programmed value greater than 9999 is treated as 9999 00000000000000 => 0 decimal 00000000000001 => 1 decimal |
| D1–D0 | Reserved | R | 00 | Reserved (write only 00) |

REGISTER 1DH: Audio Control 4

| BIT | NAME | READ/ WRITE | RESET VALUE | FUNCTION |
|--------|----------|----------------|--------------|----------------------------------------------------------------------------------------------|
| D15 | Reserved | R | 0 | Reserved. Write only 0 to this location. |
| D14 | DASTPD | R/W | 0 | DAC Soft-Stepping Control 0 => Soft-stepping is enabled 1 => Soft-stepping is disabled |
| D13–D2 | Reserved | R | 000000000000 | Reserved. Write only 000000000000 in this location. |
| D1–D0 | Reserved | R | XX | Reserved (write only 00) |

LAYOUT

The following layout suggestions should provide optimum performance from the TSC2102. However, many portable applications have conflicting requirements concerning power, cost, size, and weight. In general, most portable devices have fairly *clean* power and grounds because most of the internal components are very low power. This situation means less bypassing for the converter power and less concern regarding grounding. Still, each situation is unique and the following suggestions should be reviewed carefully.

For optimum performance, care must be taken with the physical layout of the TSC2102 circuitry. The basic SAR architecture is sensitive to glitches or sudden changes on the power supply, reference, ground connections, and digital inputs that occur just prior to latching the output of the analog comparator. Therefore, during any single conversion for an *n-bit* SAR converter, there are *n windows* in which large external transient voltages can easily affect the conversion result. Such glitches might originate from switching power supplies, nearby digital logic, and high power devices. The degree of error in the digital output depends on the reference voltage, layout, and the exact timing of the external event. The error can change if the external event changes in time with respect to the timing of the critical *n windows*.

With this in mind, power to the TSC2102 must be clean and well bypassed. A 0.1- μ F ceramic bypass capacitor must be placed as close to the device as possible. A 1- μ F to 10- μ F capacitor may also be needed if the impedance between the TSC2102 supply pins and the system power supply is high.

The VREF pin requires a minimum bypass capacitor of 0.1 μ F, although a larger value can be used to reduce the reference noise level. If an external reference voltage originates from an op-amp, make sure that it can drive any bypass capacitor that is used without oscillation.

The TSC2102 architecture offers no inherent rejection of noise or voltage variation in regards to using an external reference input. This is of particular concern when the reference input is tied to the power supply. Any noise and ripple from the supply appears directly in the digital results. While high frequency noise can be filtered out, voltage variation due to line frequency (50 Hz or 60 Hz) can be difficult to remove.

The ground pins must be connected to a clean ground point. In many cases, this is the *analog* ground. Avoid connections that are too near the grounding point of a microcontroller or digital signal processor. If needed, run a ground trace directly from the converter to the power supply entry or battery connection point. The ideal layout includes an analog ground plane dedicated to the converter and associated analog circuitry.

In the specific case of use with a resistive touch screen, care must be taken with the connection between the converter and the touch screen. Since resistive touch screens have fairly low resistance, the interconnection must be as short and robust as possible. Loose connections can be a source of error when the contact resistance changes with flexing or vibrations.

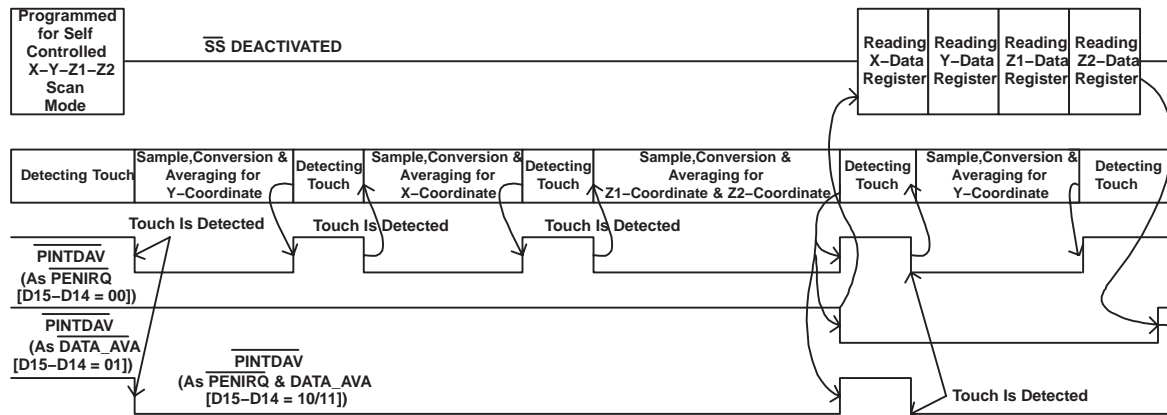
As indicated previously, noise can be a major source of error in touch-screen applications (e.g., applications that require a back-lit LCD panel). This EMI noise can be coupled through the LCD panel to the touch screen and cause *flickering* of the converted ADC data. Several things can be done to reduce this error, such as utilizing a touch screen with a bottom-side metal layer connected to ground. This couples the majority of noise to ground. Additionally, filtering capacitors, from Y+, Y–, X+, and X– to ground, can also help. Note, however, that the use of these capacitors increases screen settling time and requires longer panel voltage stabilization times, as well as increased precharge and sense times for the PINTDAV circuitry of the TSC2102.

The time for a complete X/Y/Z1/Z2 coordinate conversion is given by(not including the time needed to send the command over the SPI bus):

$$t_{\text{coordinate}} = 3 \times \left[\frac{(t_{\text{PRE}} + t_{\text{SNS}} + t_{\text{PVS}})}{125 \text{ ns}} \right] \times t_{\text{OSC}} + 4 \times \left\{ N_{\text{AVG}} \left[(N_{\text{BITS}} + 1) \times \frac{8 \text{ MHz}}{f_{\text{conv}}} + n_1 + 12 \right] + 1 \right\} \\ \times t_{\text{OSC}} + 33 \times t_{\text{OSC}} + n_2 \times t_{\text{OSC}} + n_3 \times t_{\text{OSC}}$$

$n_1 = 6$; if $f_{\text{conv}} = 8 \text{ MHz}$
 7 ; if $f_{\text{conv}} \neq 8 \text{ MHz}$
 $n_2 = 4$; if $t_{\text{PVS}} = 0 \mu\text{s}$
 0 ; if $t_{\text{PVS}} \neq 0 \mu\text{s}$
 $n_3 = 0$; if $t_{\text{SNS}} = 32 \mu\text{s}$
 3 ; if $t_{\text{SNS}} \neq 32 \mu\text{s}$

NOTE: The above formula is exactly valid only when the audio DAC is powered down. Also after touch detect the formula holds true from second conversion onwards. For continuous touch and D15–D14 = 00/10/11, the high duration of the PINTDAV signal is given by $t_{\text{PRE}} + t_{\text{SNS}}$ with an oscillator clock of 8 MHz.



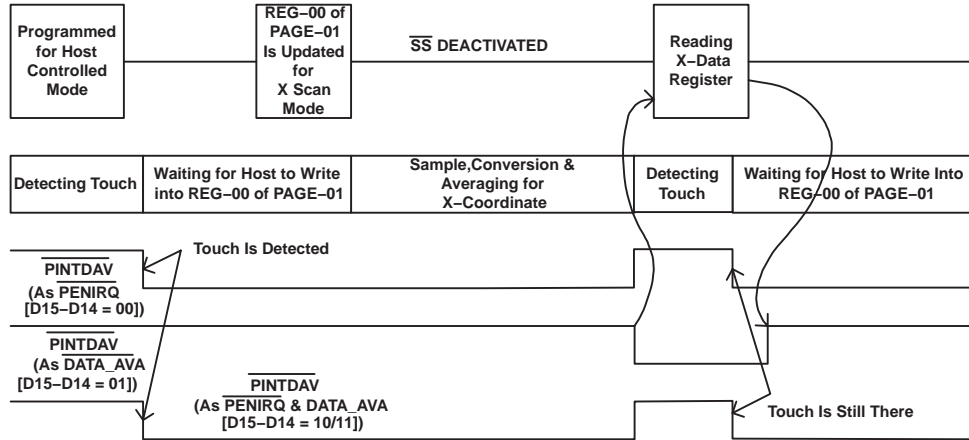
Touch Screen Conversion Initiated by the Host

The time needed to convert any single coordinate either X or Y under host control (not including the time needed to send the command over the SPI bus) is given by:

$$t_{\text{coordinate}} = \left[\frac{t_{\text{PVS}}}{125 \text{ ns}} \right] \times t_{\text{OSC}} + \left\{ N_{\text{AVG}} \left[(N_{\text{BITS}} + 1) \times \frac{8 \text{ MHz}}{f_{\text{conv}}} + n_1 + 12 \right] + 1 \right\} \\ \times t_{\text{OSC}} + 14 \times t_{\text{OSC}} + n_2 \times t_{\text{OSC}}$$

$n_1 = 6$; if $f_{\text{conv}} = 8 \text{ MHz}$
 7 ; if $f_{\text{conv}} \neq 8 \text{ MHz}$
 $n_2 = 2$; if $t_{\text{PVS}} = 0 \mu\text{s}$
 0 ; if $t_{\text{PVS}} \neq 0 \mu\text{s}$

NOTE: For continuous touch and D15–D14 = 00/10/11, the high duration of the PINTDAV signal is given by $t_{\text{PRE}} + t_{\text{SNS}}$ with an oscillator clock of 8 MHz.



The time needed to convert the Z coordinate under host control (not including the time needed to send the command over the SPI bus) is given by:

$$t_{\text{coordinate}} = \left[\frac{t_{\text{PVS}}}{125 \text{ ns}} \right] \times t_{\text{OSC}} + 2 \times \left\{ N_{\text{AVG}} \left[\left(N_{\text{BITS}} + 1 \right) \times \frac{8 \text{ MHz}}{f_{\text{conv}}} + n_1 + 12 \right] + 1 \right\} \\ \times t_{\text{OSC}} + 20 \times t_{\text{OSC}} + n_2 \times t_{\text{OSC}}$$

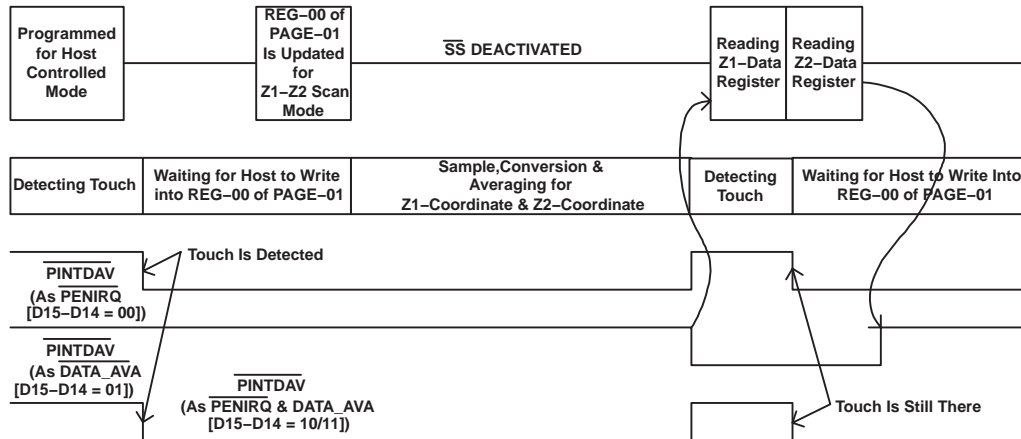
$$n_1 = 6 ; \text{ if } f_{\text{conv}} = 8 \text{ MHz}$$

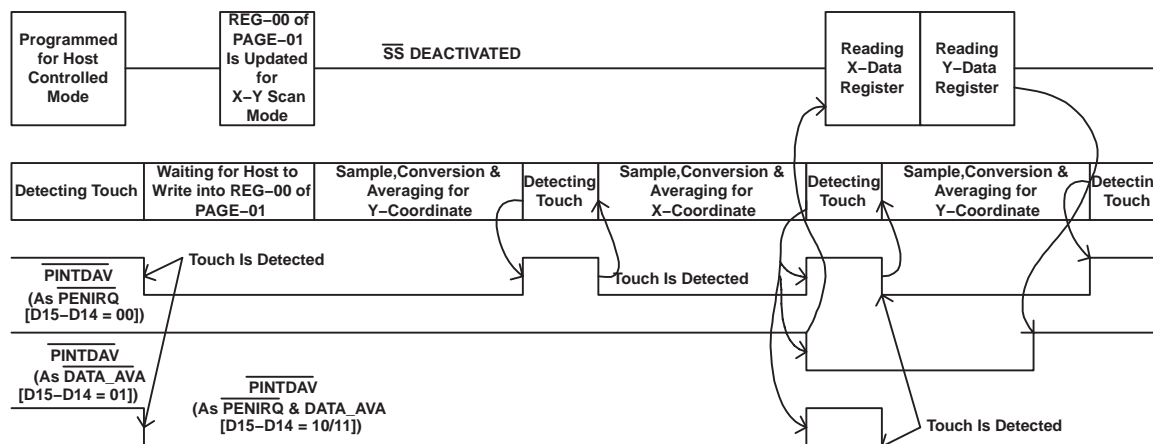
$$7 ; \text{ if } f_{\text{conv}} \neq 8 \text{ MHz}$$

$$n_2 = 2 ; \text{ if } t_{\text{PVS}} = 0 \mu\text{s}$$

$$0 ; \text{ if } t_{\text{PVS}} \neq 0 \mu\text{s}$$

NOTE: For continuous touch and D15–D14 = 00/10/11, the high duration of the PINTDAV signal is given by $t_{\text{PRE}} + t_{\text{SNS}}$ with an oscillator clock of 8 MHz.





Non-Touch Screen Measurement Operation

The time needed to make temperature, auxiliary, or battery measurements is given by:

$$t = \left\{ N_{AVG} \left[\left(N_{BITS} + 1 \right) \times \frac{8 \text{ MHz}}{f_{conv}} + n_1 + n_2 \right] + 1 \right\} \times t_{OSC} + 15 \times t_{OSC} + n_3 \times t_{OSC}$$

where:

$n_1 = 6$; if $f_{conv} = 8 \text{ MHz}$

7 ; if $f_{conv} \neq 8 \text{ MHz}$

$n_2 = 24$; if measurement is for TEMP1 case

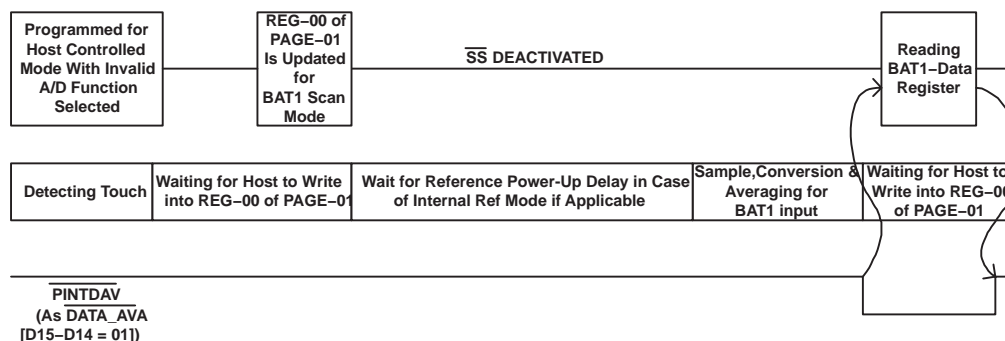
12 ; if measurement is for other than TEMP1 case

$n_3 = 0$; if external reference mode is selected

3 ; if $t_{REF} = 0 \mu\text{s}$ or reference is programmed for power up all the time.

$1 + t_{REF} / 125 \text{ ns}$; if $t_{REF} \neq 0 \mu\text{s}$ and reference needs to power down between conversions.

t_{REF} is the reference power up delay time.



The time needed for continuous AUX conversion in scan mode is given by:

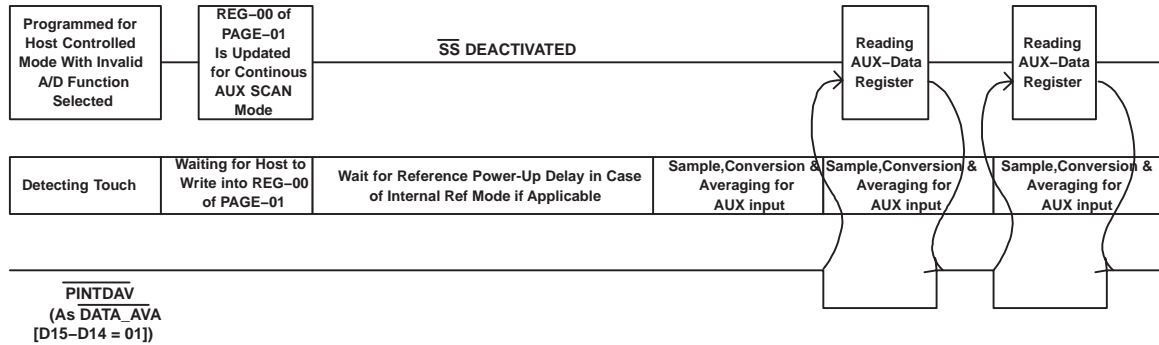
$$t = \left\{ N_{AVG} \left[\left(N_{BITS} + 1 \right) \times \frac{8 \text{ MHz}}{f_{conv}} + n_1 + 12 \right] + 1 \right\} \times t_{OSC} + 8 \times t_{OSC}$$

where:

$n_1 = 6$; if $f_{conv} = 8 \text{ MHz}$

7 ; if $f_{conv} \neq 8 \text{ MHz}$

NOTE: The above equation is valid only from second conversion onwards.



Port Scan Operation

The time needed to complete one set of port scan conversions is given by:

$$t = 3 \times \left\{ N_{AVG} \left[\left(N_{BITS} + 1 \right) \times \frac{8 \text{ MHz}}{f_{conv}} + n_1 + 12 \right] + 1 \right\} \times t_{OSC} + 31 \times t_{OSC} + n_2 \times t_{OSC}$$

where:

$n_1 = 6$; if $f_{conv} = 8 \text{ MHz}$

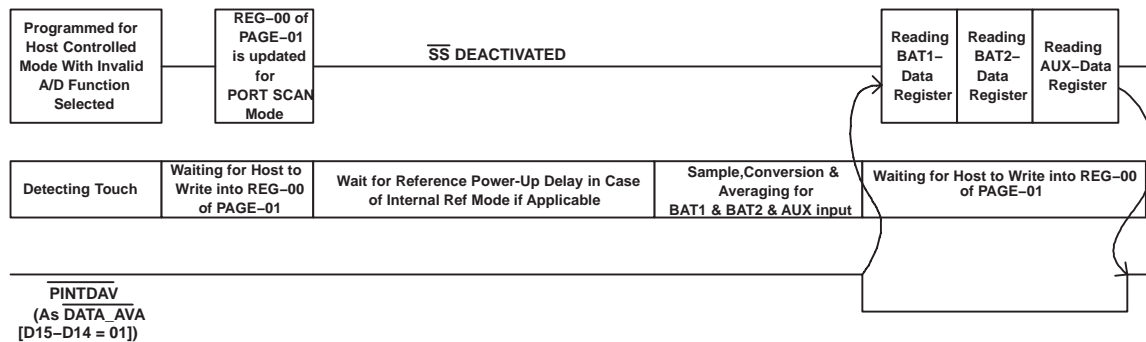
7 ; if $f_{conv} \neq 8 \text{ MHz}$

$n_2 = 0$; if external reference mode is selected

3 ; if $t_{REF} = 0 \mu\text{s}$ or reference is programmed for power up all the times.

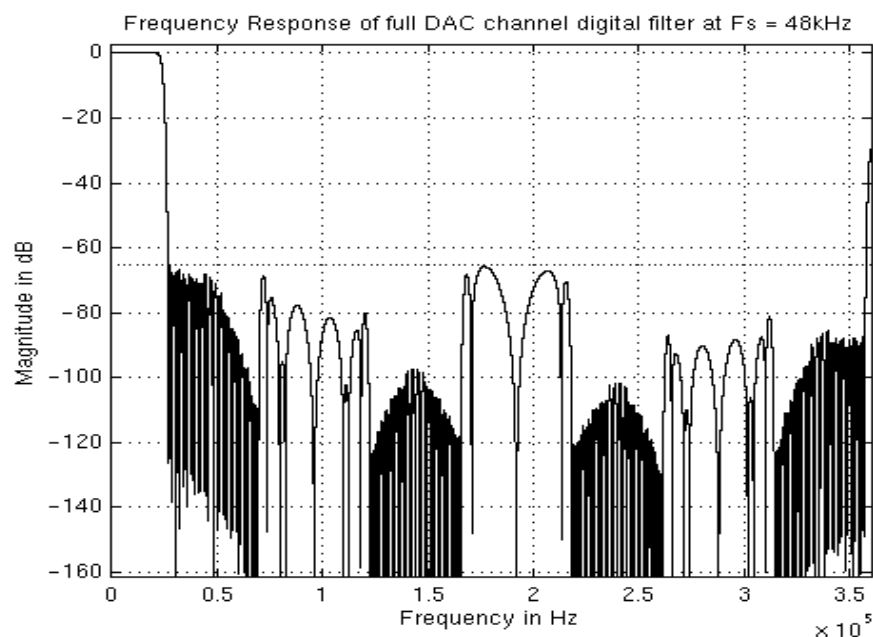
1 + $t_{REF} / 125 \text{ ns}$; if $t_{REF} \neq 0 \mu\text{s}$ and reference needs to power down between conversions.

t_{REF} is the reference power up delay time.

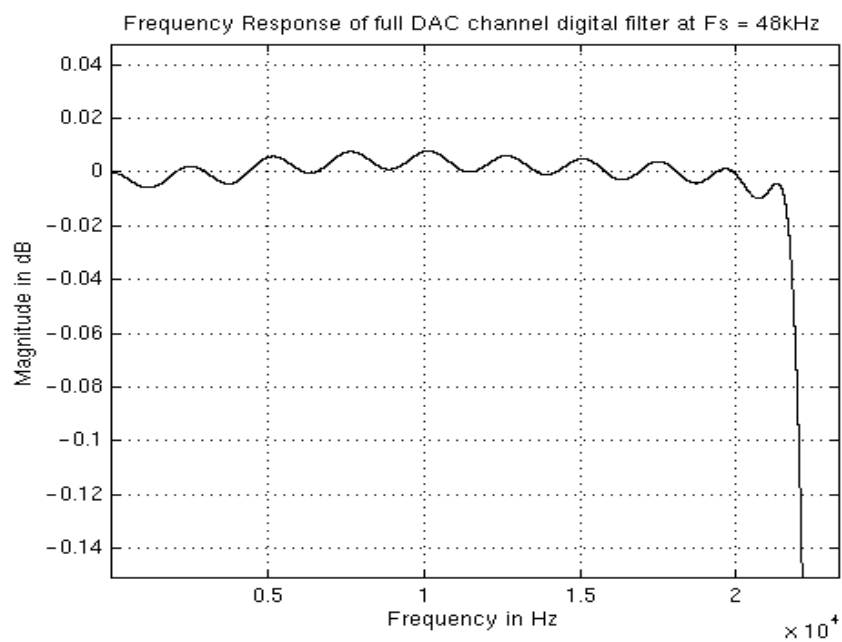


DAC CHANNEL DIGITAL FILTER

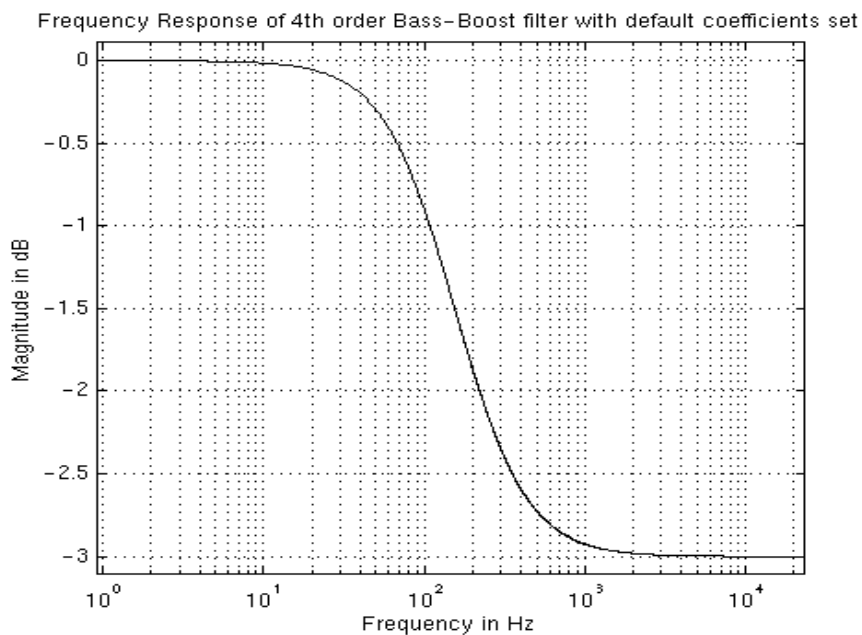
DAC Channel Digital Filter Frequency Response



DAC Channel Digital Filter Pass-Band Frequency Response

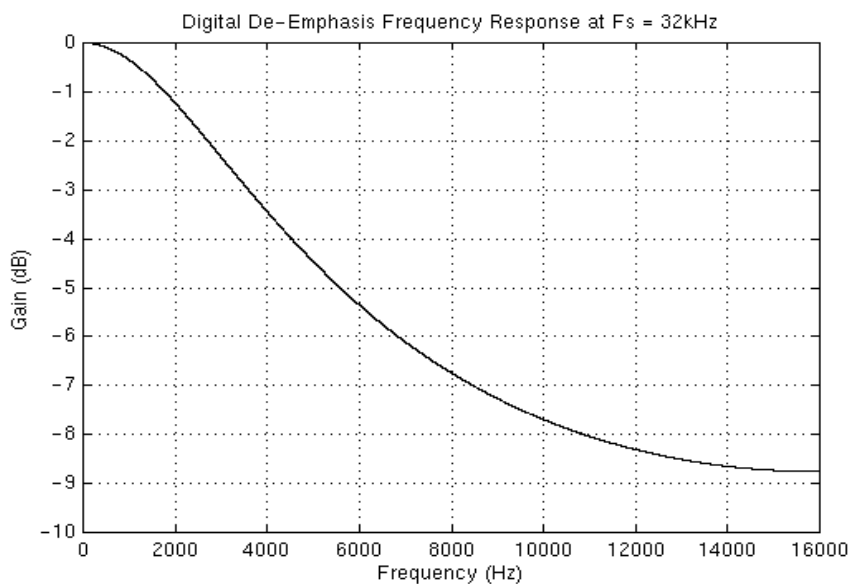


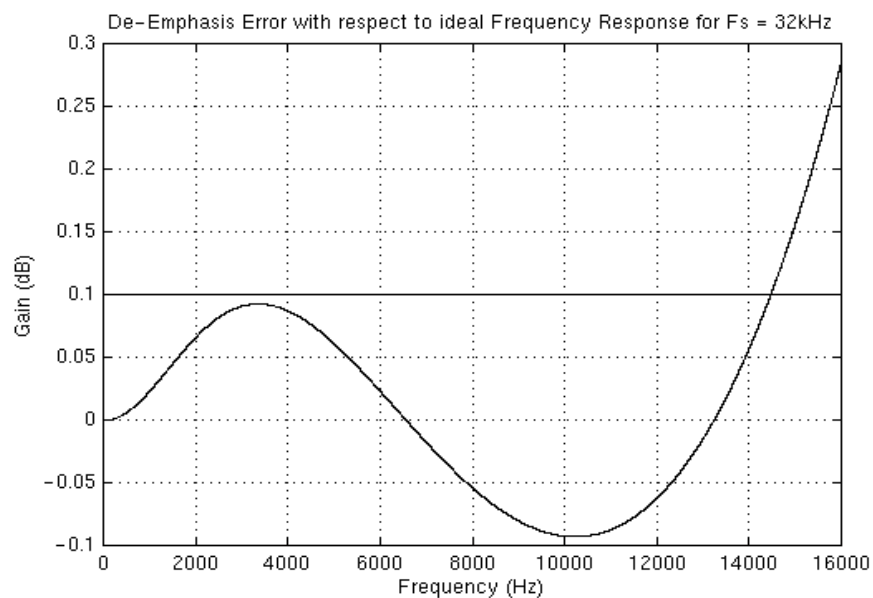
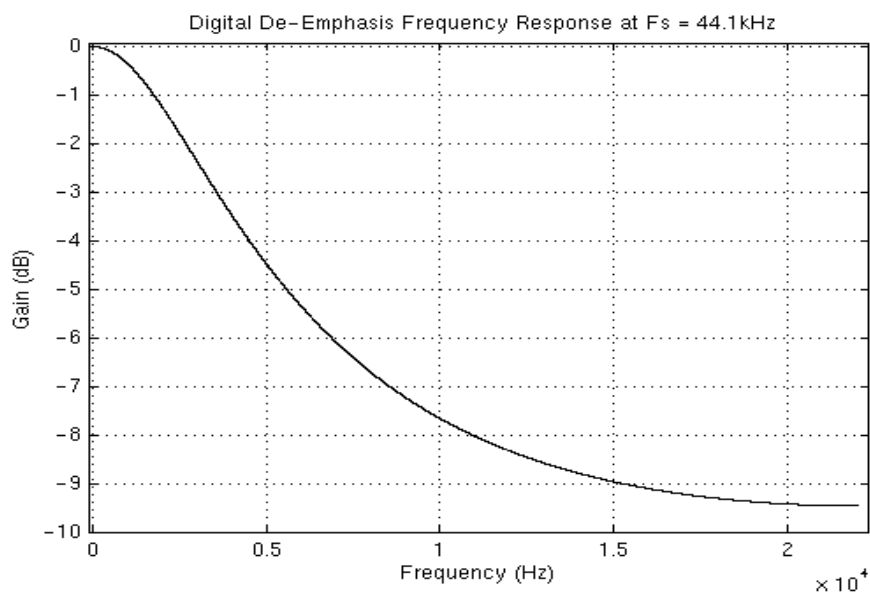
DEFAULT BASS-BOOST FREQUENCY RESPONSE AT 48 kbps



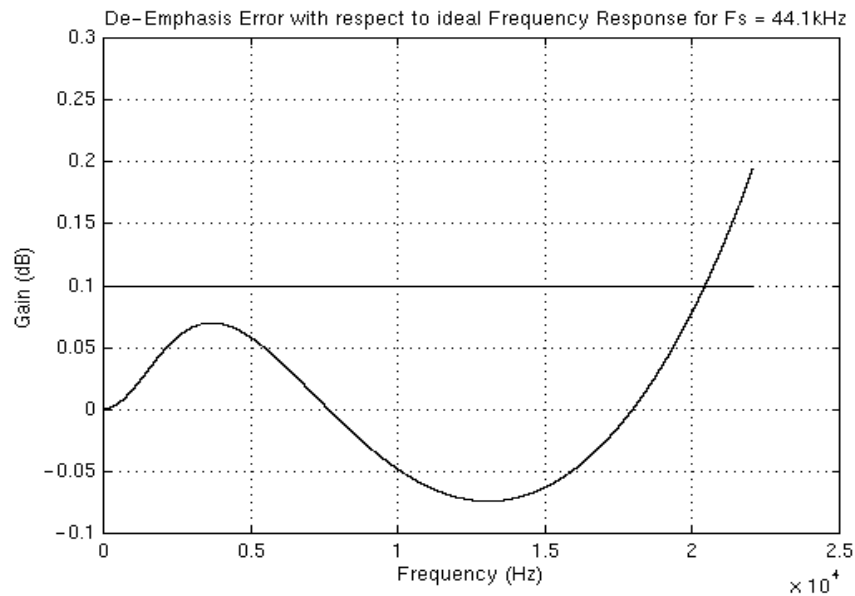
DE-EMPHASIS FILTER FREQUENCY RESPONSE

De-Emphasis Filter Response at 32 kbps

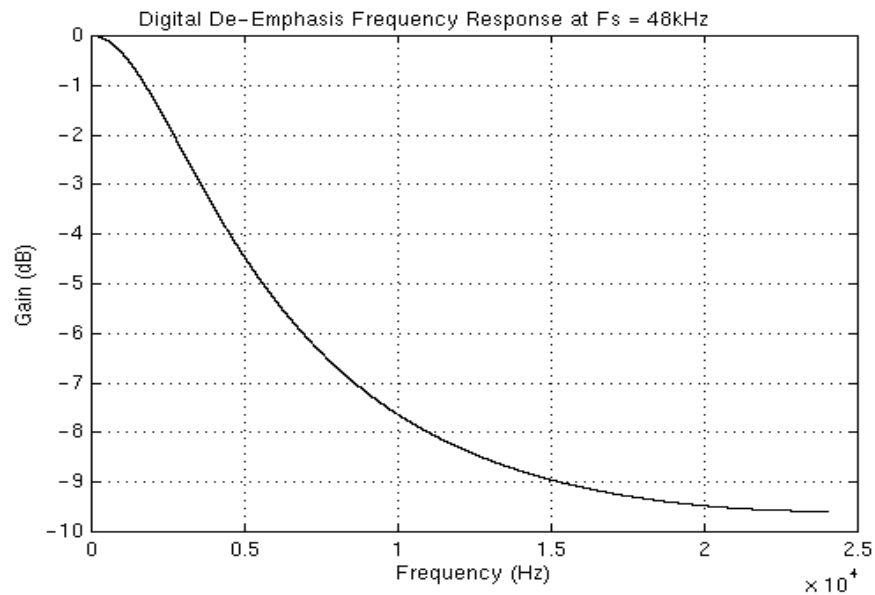


De-Emphasis Error at 32 kbps**De-Emphasis Filter Frequency Response at 44.1 kbps**

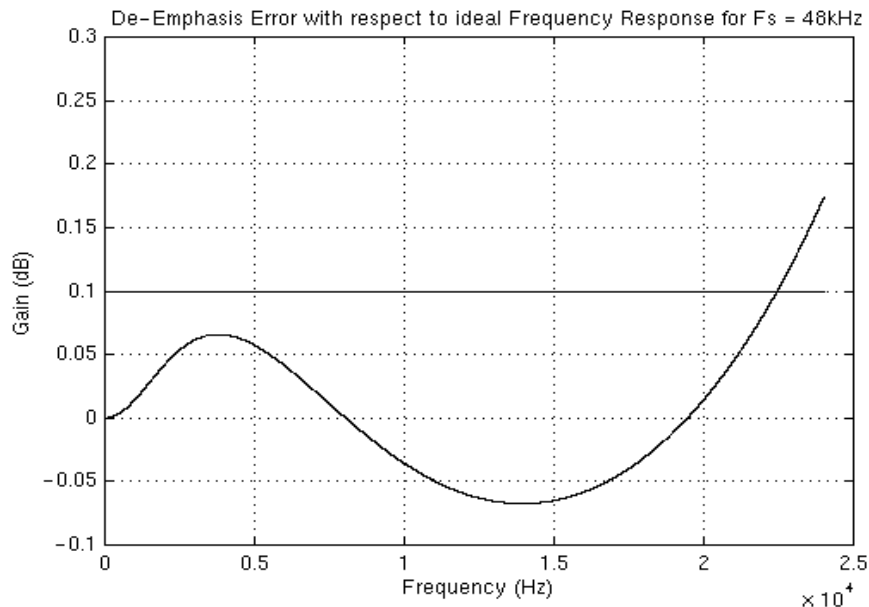
De-Emphasis Error at 44.1 ksp/s



De-Emphasis Frequency Response at 48 ksp/s



De-Emphasis Error at 48 ksp/s



PLL PROGRAMMING

The on-chip PLL in the TSC2102 can be used to generate sampling clocks from a wide range of MCLK's available in a system. The PLL works by generating oversampled clocks with respect to F_{sref} (44.1 kHz or 48 kHz). Frequency division generates all other internal clocks. The table below gives a sample programming for PLL registers for some standard MCLKs when PLL is required. Whenever the MCLK is of the form of $N \times 128 \times F_{sref}$ ($N=2,3,\dots$), PLL is not required.

$F_{sref} = 44.1\text{ kHz}$

| MCLK (MHz) | P | J | D | ACHIEVED FSREF | % ERROR |
|------------|---|----|------|----------------|---------|
| 2.8224 | 1 | 32 | 0 | 44100.00 | 0.0000 |
| 5.6448 | 1 | 16 | 0 | 44100.00 | 0.0000 |
| 12 | 1 | 7 | 5264 | 44100.00 | 0.0000 |
| 13 | 1 | 6 | 9474 | 44099.71 | 0.0007 |
| 16 | 1 | 5 | 6448 | 44100.00 | 0.0000 |
| 19.2 | 1 | 4 | 7040 | 44100.00 | 0.0000 |
| 19.68 | 1 | 4 | 5893 | 44100.30 | -0.0007 |
| 48 | 4 | 7 | 5264 | 44100.00 | 0.0000 |

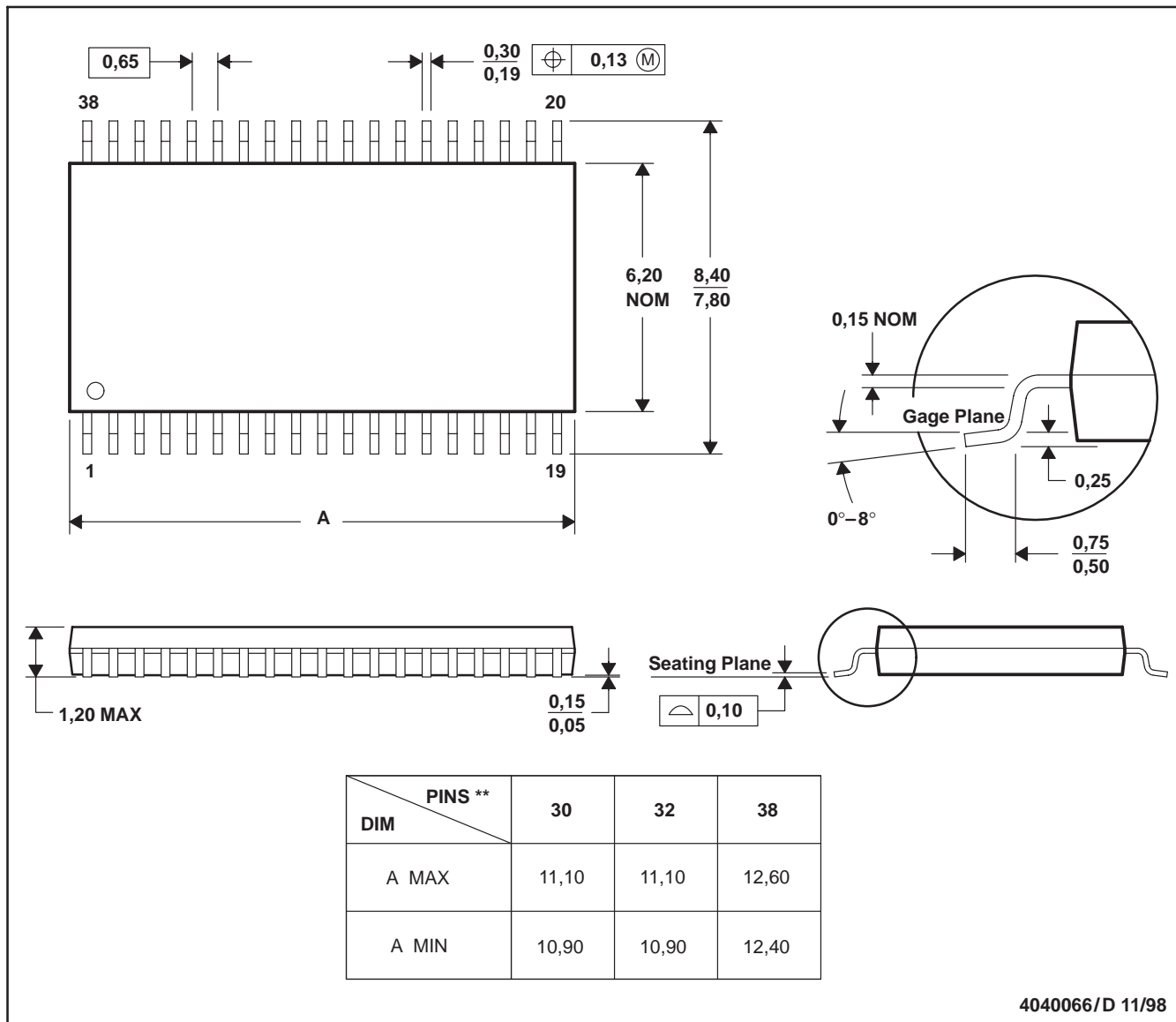
$F_{sref} = 48\text{ kHz}$

| MCLK (MHz) | P | J | D | ACHIEVED FSREF | % ERROR |
|------------|---|----|------|----------------|---------|
| 2.048 | 1 | 48 | 0 | 48000.00 | 0.0000 |
| 3.072 | 1 | 32 | 0 | 48000.00 | 0.0000 |
| 4.096 | 1 | 24 | 0 | 48000.00 | 0.0000 |
| 6.144 | 1 | 16 | 0 | 48000.00 | 0.0000 |
| 8.192 | 1 | 12 | 0 | 48000.00 | 0.0000 |
| 12 | 1 | 8 | 1920 | 48000.00 | 0.0000 |
| 13 | 1 | 7 | 5618 | 47999.71 | 0.0006 |
| 16 | 1 | 6 | 1440 | 48000.00 | 0.0000 |
| 19.2 | 1 | 5 | 1200 | 48000.00 | 0.0000 |
| 19.68 | 1 | 4 | 9951 | 47999.79 | 0.0004 |
| 48 | 4 | 8 | 1920 | 48000.00 | 0.0000 |

DA (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

38 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion.
 D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| Products | | Applications | |
|------------------|--------------------------------------------------------------------|---------------------|--------------------------------------------------------------------------|
| Amplifiers | amplifier.ti.com | Audio | www.ti.com/audio |
| Data Converters | dataconverter.ti.com | Automotive | www.ti.com/automotive |
| DSP | dsp.ti.com | Broadband | www.ti.com/broadband |
| Interface | interface.ti.com | Digital Control | www.ti.com/digitalcontrol |
| Logic | logic.ti.com | Military | www.ti.com/military |
| Power Mgmt | power.ti.com | Optical Networking | www.ti.com/opticalnetwork |
| Microcontrollers | microcontroller.ti.com | Security | www.ti.com/security |
| | | Telephony | www.ti.com/telephony |
| | | Video & Imaging | www.ti.com/video |
| | | Wireless | www.ti.com/wireless |

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

Copyright © 2004, Texas Instruments Incorporated



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.